# SPECIAL ENVIRONMENT 80960CF-30, -25, -16 32-BIT HIGH-PERFORMANCE SUPERSCALAR PROCESSOR 

- Socket and Object Code Compatible with 80960CA
- Two Instructions/Clock Sustained Execution
- Four 59 Mbytes/s DMA Channels with Data Chaining
- Demultiplexed 32-bit Burst Bus with Pipelining

32-bit Parallel Architecture

- Two Instructions/clock Execution
- Load/Store Architecture
- Sixteen 32-bit Global Registers
- Sixteen 32-bit Local Registers
— Manipulate 64-bit Bit Fields
- 11 Addressing Modes
- Full Parallel Fault Model
- Supervisor Protection Model
- Fast Procedure Call/Return Model
- Full Procedure Call in 4 clocks

■ On-Chip Register Cache

- Caches Registers on Call/Ret
- Minimum of 6 Frames provided
- Up to 15 Programmable Frames

■ On-Chip Instruction Cache

- 4 Kbyte Two-Way Set Associative
- 128-bit Path to Instruction Sequencer
- Cache-Lock Modes
- Cache-Off Mode
- On-Chip Data Cache
- 1 Kbyte Direct-Mapped, Write Through
- 128 bits per Clock Access on Cache Hit
Product Grades Available
- SE3: $-40^{\circ} \mathrm{C}$ to $+110^{\circ} \mathrm{C}$

■ High Bandwidth On-Chip Data RAM

- 1 Kbytes On-Chip RAM for Data
- Sustain 128 bits per clock access
- Four On-Chip DMA Channels
- 59 Mbytes/s Fly-by Transfers
- 32 Mbytes/s Two-Cycle Transfers
- Data Chaining
—Data Packing/Unpacking
- Programmable Priority Method

32-Bit Demultiplexed Burst Bus - 128-bit Internal Data Paths to and from Registers

- Burst Bus for DRAM Interfacing
- Address Pipelining Option
- Fully Programmable Wait States
- Supports 8, 16 or 32-bit Bus Widths
- Supports Unaligned Accesses
- Supervisor Protection Pin

Selectable Big or Little Endian Byte Ordering
■ High-Speed Interrupt Controller - Up to 248 External Interrupts

- 32 Fully Programmable Priorities
- Multi-mode 8-bit Interrupt Port
- Four Internal DMA Interrupts
- Separate, Non-maskable Interrupt Pin
- Context Switch in 750 ns Typical


271328-1
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### 1.0 PURPOSE

This document previews electrical characterizations of Intel's i960 CF embedded microprocessor (available in 33,25 and 16 MHz ). For a detailed description of any i960 CF processor functional topic-other than parametric performance-refer to the latest i960 CA Microprocessor Reference Manual (Order No. 270710) and the i960 CF Reference Manual Addendum (Order No. 272188).

## 2.0 i960 CF PROCESSOR OVERVIEW

Intel's i960 CF microprocessor is the performance follow-on product to the i960 CA processor. The i960 CF product is socket- and object code-compatible with the CA; this makes CA-to-CF design upgrades straightforward. The 9960 CF processor's instruction cache is 4 Kbytes (CA device has 1 Kbyte); CF data cache is 1 Kbyte (CA device has no data cache). This extra cache on the CF product adds a significant performance boost over the CA. The 80960CF is object code compatible with the 32-bit 80960 Core Architecture while including Special Function Register extensions to control on-chip peripherals, and instruction set extensions to shift 64bit operands and configure on-chip hardware. Multiple 128-bit internal busses, on-chip instruction caching and a sophisticated instruction scheduler allow the processor to sustain execution of two instruc-
tions every clock, and peak at execution of three instructions per clock.

A 32-bit demultiplexed and pipelined burst bus provides a 132 Mbyte/s bandwidth to a system's highspeed external memory sub-system. In addition, the 80960CF's on-chip caching of instructions, procedure context and critical program data substantially decouples system performance from the wait states associated with accesses to the system's slower, cost sensitive, main memory sub-system.

The 80960CF bus controller also integrates full wait state and bus width control for highest system performance with minimal system design complexity. Unaligned access and Big Endian byte order support reduces the cost of porting existing applications to the 80960CF.

The processor also integrates four complete datachaining DMA channels and a high-speed interrupt controller on-chip. The DMA channels perform: sin-gle-cycle or two-cycle transfers, data packing and unpacking, and data chaining. Block transfers, in addition to source or destination synchronized transfers, are provided.

The interrupt controller provides full programmability of 248 interrupt sources into 32 priority levels with a typical interrupt task switch ("latency") time of 750 ns.


Figure 2. 80960CF Block Diagram

### 2.1. The C-Series Core

The C-Series core is a very high performance microarchitectural implementation of the 80960 Core Architecture. The C-Series core can sustain execution of two instructions per clock ( 66 MIPs at 33 MHz ). To achieve this level of performance, Intel has incorporated state-of-the-art silicon technology and innovative microarchitectural constructs into the implementation of the C-Series core. Factors that contribute to the core's performance include:

- Parallel instruction decoding allows issue of up to three instructions per clock.
- Most instructions execute in a single clock.
- Parallel instruction decode allows sustained, simultaneous execution of two single-clock instructions every clock cycle.
- Efficient instruction pipeline minimizes pipeline break losses.
- Register and resource scoreboarding allow simultaneous multi-clock instruction execution.
- Branch look-ahead and prediction allows many branches to execute with no pipeline break.
- Local Register Cache integrated on-chip caches Call/Return context.
- Two-way set associative, 4 Kbyte integrated instruction cache.
- Direct mapped, 1 Kbyte data cache, write through, write allocate.
- 1 Kbyte integrated Data RAM sustains a fourword (128-bit) access every clock cycle.


### 2.2. Pipelined, Burst Bus

A 32-bit high performance bus controller interfaces the 80960CF to external memory and peripherals. The Bus Control Unit features a maximum transfer rate of 132 Mbytes per second (at 33 MHz ). Internally programmable wait states and 16 separately configurable memory regions allow the processor to interface with a variety of memory subsystems with a minimum of system complexity and a maximum of performance. The Bus Controller's main features include:

- Demultiplexed, Burst Bus to exploit most efficient DRAM access modes.
- Address Pipelining to reduce memory cost while maintaining performance.
- 32-, 16- and 8-bit modes for I/O interfacing ease.
- Full internal wait state generation to reduce system cost.
- Little and Big Endian support to ease application development.
- Unaligned access support for code portability.
- Three-deep request queue to decouple the bus from the core.


### 2.3. Flexible DMA Controller

A four channel DMA controller provides high speed DMA control for data transfers involving peripherals and memory. The DMA provides advanced features such as data chaining, byte assembly and disassembly, and a high performance fly-by mode capable of transfer speed of up to 59 Mbytes per second at 33 MHz . The DMA controller features a performance and flexibility which is only possible by integrating the DMA controller and the 80960CF core.

### 2.4. Priority Interrupt Controller

A programmable-priority interrupt controller manages up to 248 external sources through the 8-bit external interrupt port. The Interrupt Unit also handles the four internal sources from the DMA controller, and a single non-maskable interrupt input. The 8 -bit interrupt port can also be configured to provide individual interrupt sources that are level or edge triggered.

Interrupts in the 80960CF are prioritized and signaled within 270 ns of the request. If the interrupt is of higher priority than the processor priority, the context switch to the interrupt routine typically is complete in another 480 ns . The interrupt unit provides the mechanism for the low latency and high throughput interrupt service which is essential for embedded applications.

### 2.5. Instruction Set Summary

The following table summarizes the 80960CF instruction set by logical groupings. See the i960 CA Microprocessor Reference Manual for a complete description of the instruction set.

| Data Movement | Arithmetic | Logical | Bit, Bit Field and Byte |
| :---: | :---: | :---: | :---: |
| Load <br> Store <br> Move <br> Load Address | Add <br> Subtract <br> Multiply <br> Divide <br> Remainder <br> Modulo <br> Shift <br> *Extended <br> Shift <br> Extended <br> Multiply <br> Extended <br> Divide <br> Add with Carry <br> Subtract with Carry <br> Rotate | And <br> Not And <br> And Not <br> Or <br> Exclusive Or <br> Not Or <br> Or Not <br> Nor <br> Exclusive Nor <br> Not <br> Nand | Set Bit <br> Clear Bit <br> Not Bit <br> Alter Bit <br> Scan for Bit <br> Span over Bit <br> Extract <br> Modify <br> Scan Byte for Equal |
| Comparison | Branch | Call and Return | Fault |
| Compare <br> Conditional <br> Compare <br> Compare and Increment <br> Compare and <br> Decrement <br> Test Condition Code Check Bit | Unconditional Branch Conditional Branch Compare and Branch | Call <br> Call Extended <br> Call System <br> Return <br> Branch and Link | Conditional Fault Synchronize Faults |
| Debug | Processor Management | Atomic |  |
| Modify Trace Controls Mark Force Mark | Modify <br> Process Controls <br> Modify Arithmetic Controls *System Control <br> *DMA Control <br> Flush Local Registers | Atomic Add Atomic Modify |  |

NOTE:
Instructions marked by ( ${ }^{*}$ ) are 80960CF extensions to the 80960 instruction set.

### 3.0 PACKAGE INFORMATION

### 3.1. Package Introduction

This section describes the pins, pinouts and thermal characteristics for the 80960CF in the 168-pin Ceramic Pin Grid Array (PGA) package. For complete package specifications and information, see the Intel Packaging Outlines and Dimensions Guide (Order No. 231369).

### 3.2. Pin Descriptions

The 80960CF pins are described in this section. Table 1 presents the legend for interpreting the pin descriptions in the following tables.

Pins associated with the 32-bit demultiplexed processor bus are described in Table 2. Pins associated with basic processor configuration and control are described in Table 3. Pins associated with the 80960CF DMA Controller and Interrupt Unit are described in Table 4.

Figure 3 provides an example pin description table entry. "I/O" signifies that data pins are input-output. " S " indicates pins are synchronous to PCLK2:1. " $\mathrm{H}(\mathrm{Z})$ " indicates that these pins float while the processor bus is in a Hold Acknowledge state. " $R(Z)$ " indicates that the pins also float while RESET is low.

All pins float while the processor is in the ONCE mode.

Table 1. Pin Description Nomenclature

| Symbol | Description |
| :---: | :---: |
| 1 | Input only pin |
| 0 | Output only pin |
| I/O | Pin can be either an input or output |
|  | Pins "must be" connected as described |
| S(...) | Synchronous. Inputs must meet setup and hold times relative to PCLK2:1 for proper operation. All outputs are synchronous to PCLK2:1. <br> S(E) Edge sensitive input <br> $\mathrm{S}(\mathrm{L})$ Level sensitive input |
| A(...) | Asynchronous. Inputs may be asynchronous to PCLK2:1. <br> A(E) Edge sensitive input <br> A(L) Level sensitive input |
| H(...) | While the processor's bus is in the Hold Acknowledge or Bus Backoff state, the pin: <br> $H(1)$ is driven to $V_{C C}$ <br> $H(0) \quad$ is driven to $V_{S S}$ <br> $\mathrm{H}(\mathrm{Z})$ floats <br> $H(Q) \quad$ continues to be a valid output |
| R(...) | While the processor's $\overline{\text { RESET }}$ pin is low, the pin <br> $R(1)$ is driven to $V_{C C}$ <br> $R(0) \quad$ is driven to $V_{S S}$ <br> $R(Z)$ floats <br> $R(Q) \quad$ continues to be a valid output |


| Name | Type | Description |
| :---: | :---: | :--- |
| D31:0 | I/O | DATA BUS carries 32-, 16- or 8-bit data quantities depending on bus width configuration. |
|  | S(L) | The least significant bit of the data is carried on D0 and the most significant on D31. When |
|  | H(Z) | the bus is configured for 8-bit data, the lower 8 data lines, D7:0 are used. For 16-bit bus |
|  | R(Z) | widths, D15:0 are used. For 32-bit bus widths the full data bus is used. |

Figure 3. Example Pin Description Entry

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Table 2. 80960CF Pin Description-External Bus Signals

| Name | Type | Description |
| :---: | :---: | :---: |
| A31:2 | $\begin{gathered} 0 \\ S \\ H(Z) \\ R(Z) \end{gathered}$ | ADDRESS BUS carries the physical address upper 30 bits. A31 is the most significant address bit and A2 is the least significant. During a bus access, A31:2 identify all external addresses to word (4-byte) boundaries. The byte enable signals indicate the selected byte in each word. During burst accesses, A3 and A2 increment to indicate successive data cycles. |
| D31:0 | $\begin{aligned} & \text { I / O } \\ & \mathrm{S}(\mathrm{~L}) \\ & \mathrm{H}(\mathrm{Z}) \\ & \mathrm{R}(\mathrm{Z}) \end{aligned}$ | DATA BUS carries 32-, 16- or 8-bit data quantities depending on bus width configuration. The least significant bit of the data is carried on D0 and the most significant on D31. When the bus is configured for 8-bit data, the lower 8 data lines, D7:0 are used. For 16-bit bus widths, D15:0 are used. For 32-bit bus widths the full data bus is used. |
| $\begin{aligned} & \overline{\overline{B E 3}} \\ & \overline{\mathrm{BE} 2} \\ & \overline{\mathrm{BE}} \\ & \overline{\mathrm{BEO}} \end{aligned}$ | $\begin{gathered} 0 \\ S \\ H(Z) \\ R(1) \end{gathered}$ | BYTE ENABLES select which of the four bytes addressed by A31:2 are active during an access to a memory region configured for a 32-bit data-bus width. $\overline{\mathrm{BE}} 3$ applies to D31:24; $\overline{\text { BE2 }}$ applies to D23:16; $\overline{\mathrm{BE}}$ applies to D15:8; and $\overline{\mathrm{BE}}$ applies to D7:0. <br> 32-bit bus: $\overline{\text { BE3 }} \quad$-Byte Enable $3 \quad$-enable D31:24 <br> BE2 -Byte Enable 2 -enable D23:16 <br> $\overline{\mathrm{BE} 1}$-Byte Enable $1 \quad$-enable D15:8 <br> $\overline{\mathrm{BEO}}$-Byte Enable $0 \quad$-enable D7:0 <br> For accesses to a memory region configured for a 16-bit data-bus width, the processor directly encodes $\overline{\mathrm{BE} 3}, \overline{\mathrm{BE}} 1$ and $\overline{\mathrm{BE}}$ to provided $\overline{\mathrm{BHE}}, \mathrm{A} 1$ and $\overline{\mathrm{BLE}}$ respectively. <br> For accesses to a memory region configured for an 8-bit data bus width, the processor directly encodes $\overline{\mathrm{BE} 1}$ and $\overline{\mathrm{BEO}}$ to provide A 1 and A 0 respectively. |
| W/ $/$ R | $\begin{gathered} 0 \\ S \\ H(Z) \\ R(0) \\ \hline \end{gathered}$ | WRITE/READ is asserted for read requests and deasserted for write requests. The W/ $\bar{R}$ signal changes in the same clock cycle as $\overline{A D S}$. It remains valid for the entire access in non-pipelined regions. In pipelined regions, $W / \bar{R}$ is not guaranteed valid in the last cycle of a read access. |
| $\overline{\text { ADS }}$ | $\begin{gathered} \mathrm{O} \\ \mathrm{~S} \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(1) \\ \hline \end{gathered}$ | ADDRESS STROBE indicates valid address and the start of a new bus access. $\overline{\mathrm{ADS}}$ is asserted for the first clock of a bus access. |
| READY | $\begin{gathered} \text { I } \\ \mathrm{S}(\mathrm{~L}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \end{gathered}$ | READY is an input which signals the termination of a data transfer. $\overline{\text { READY }}$ is used to indicate that read data on the bus is valid, or that a write-data transfer has completed. The READY signal works in conjunction with the internally programmed wait-state generator. If $\overline{R E A D Y}$ is enabled in a region, the pin is sampled after the programmed number of wait-states has expired. If the READY pin is deasserted, wait states continue to be inserted until READY becomes asserted. This is true for the $N_{\text {RAD }}, N_{\text {RDD }}, N_{\text {WAD }}$, and NWDD wait states. The $\mathrm{N}_{\text {XDA }}$ wait states cannot be extended. |

Table 2. 80960CF Pin Description-External Bus Signals (Continued)

| Name | Type | Description |
| :---: | :---: | :---: |
| $\overline{\text { BTERM }}$ | $\begin{gathered} \hline \mathbf{I} \\ \mathrm{S}(\mathrm{~L}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \end{gathered}$ | BURST TERMINATE-The burst terminate signal breaks up a burst access and causes another address cycle to occur. The BTERM signal works in conjunction with the internally programmed wait-state generator. If READY and BTERM are enabled in a region, the BTERM pin is sampled after the programmed number of wait states has expired. When $\overline{B T E R M}$ is asserted, a new $\overline{\text { ADS }}$ signal is generated and the access is completed. The READY input is ignored when BTERM is asserted. BTERM must be externally synchronized to satisfy the BTERM setup and hold times. |
| $\overline{\text { WAIT }}$ | $\begin{gathered} 0 \\ S \\ H(Z) \\ R(1) \end{gathered}$ | WAIT indicates internal wait state generator status. WAIT is asserted when wait states are being caused by the internal wait state generator and not by the READY or BTERM inputs. WAIT can be used to derive a write-data strobe. WAIT can also be thought of as a READY output that the processor provides when it is inserting wait states. |
| BLAST | $\begin{gathered} \hline \mathbf{O} \\ S \\ H(Z) \\ R(0) \end{gathered}$ | BURST LAST indicates the last transfer in a bus access. BLAST is asserted in the last data transfer of burst and non-burst accesses after the wait state counter reaches zero. BLAST remains asserted until the clock following the last cycle of the last data transfer of a bus access. If the READY or BTERM input is used to extend wait states, the $\overline{\text { BLAST signal remains asserted until } \overline{\text { READY }} \text { or } \overline{\text { BTERM }}}$ terminates the access. |
| DT/ $\bar{R}$ | $\begin{gathered} \hline \mathbf{O} \\ \mathrm{S} \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(0) \end{gathered}$ | DATA TRANSMIT/RECEIVE indicates direction for data transceivers. DT/ $\overline{\mathrm{R}}$ is used in conjunction with $\overline{D E N}$ to provide control for data transceivers attached to the external bus. When $D T / \bar{R}$ is asserted, the signal indicates that the processor receives data. Conversely, when deasserted, the processor sends data. DT/ $\bar{R}$ changes only while DEN is high. |
| $\overline{\text { DEN }}$ | $\begin{gathered} \hline \mathbf{O} \\ S \\ H(Z) \\ R(1) \end{gathered}$ | DATA ENABLE indicates data cycles in a bus request. $\overline{\mathrm{DEN}}$ is asserted at the start of the bus request first data cycle and is deasserted at the end of the last data cycle. $\overline{\mathrm{DEN}}$ is used in conjunction with $\mathrm{DT} / \overline{\mathrm{R}}$ to provide control for data transceivers attached to the external bus. $\overline{\mathrm{DEN}}$ remains asserted for sequential reads from pipelined memory regions. $\overline{D E N}$ is deasserted when $D T / \bar{R}$ changes. |
| $\overline{\text { LOCK }}$ | $\begin{gathered} \hline \mathbf{O} \\ S \\ H(Z) \\ R(1) \end{gathered}$ | BUS LOCK indicates that an atomic read-modify-write operation is in progress. LOCK may be used to prevent external agents from accessing memory which is currently involved in an atomic operation. $\overline{\text { OOCK }}$ is asserted in the first clock of an atomic operation, and deasserted in the clock cycle following the last bus access for the atomic operation. To allow the most flexibility for a memory system enforcement of locked accesses, the processor acknowledges a bus hold request when $\overline{\text { LOCK }}$ is asserted. The processor performs DMA transfers while $\overline{\text { LOCK is }}$ active. |
| HOLD | $\begin{gathered} \hline \mathrm{I} \\ \mathrm{~S}(\mathrm{~L}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \\ \hline \end{gathered}$ | HOLD REQUEST signals that an external agent requests access to the external bus. The processor asserts HOLDA after completing the current bus request. HOLD, HOLDA and BREQ are used together to arbitrate access to the processor's external bus by external bus agents. |
| $\overline{\text { BOFF }}$ | $\begin{gathered} \hline \mathrm{I} \\ \mathrm{~S}(\mathrm{~L}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \end{gathered}$ | BUS BACKOFF -The backoff pin, when asserted, suspends the current access and causes the bus pins to float. When deasserted, the ADS signal is asserted on the next clock cycle and the access is resumed. |

Table 2. 80960CF Pin Description—External Bus Signals (Continued)

| Name | Type | Description |
| :---: | :---: | :---: |
| HOLDA | $\begin{gathered} 0 \\ S \\ H(1) \\ R(Q) \end{gathered}$ | HOLD ACKNOWLEDGE indicates to a bus requestor that the processor has relinquished control of the external bus. When HOLDA is asserted, the external address bus, data bus and bus control signals are floated. HOLD, BOFF, HOLDA and BREQ are used together to arbitrate access to the processor's external bus by external bus agents. Since the processor grants HOLD requests and enters the Hold Acknowledge state even while RESET is asserted, HOLDA pin state is independent of the RESET pin. |
| BREQ | $\begin{gathered} \hline 0 \\ S \\ H(Q) \\ R(0) \end{gathered}$ | BUS REQUEST is asserted when the bus controller has a request pending. BREQ can be used by external bus arbitration logic in conjunction with HOLD and HOLDA to determine when to return mastership of the external bus to the processor. |
| D/C | $\begin{gathered} 0 \\ S \\ H(Z) \\ R(Z) \end{gathered}$ | DATA OR CODE is asserted for a data request and deasserted for instruction requests. $D / \overline{\mathrm{C}}$ has the same timing as $\mathrm{W} / \overline{\mathrm{R}}$. |
| $\overline{\text { DMA }}$ | $\begin{gathered} 0 \\ S \\ H(Z) \\ R(Z) \end{gathered}$ | DMA ACCESS indicates whether the bus request was initiated by the DMA controller. DMA is asserted for any DMA request. $\overline{\text { DMA }}$ is deasserted for all other requests. |
| $\overline{\text { SUP }}$ | $\begin{gathered} 0 \\ S \\ \mathrm{~S}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \end{gathered}$ | SUPERVISOR ACCESS indicates whether the bus request is issued while in supervisor mode. SUP is asserted when the request has supervisor privileges, and is deasserted otherwise. SUP can be used to isolate supervisor code and data structures from non-supervisor requests. |

Table 3. 80960CF Pin Description-Processor Control Signals

| Name | Type | Description |
| :---: | :---: | :---: |
| RESET | $\begin{gathered} \text { I } \\ \mathrm{A}(\mathrm{~L}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \\ \mathrm{N}(\mathrm{Z}) \end{gathered}$ | $\overline{\text { RESET }}$ causes the chip to reset. When RESET is asserted, all external signals return to the reset state. When RESET is deasserted, initialization begins. When the $2-x$ clock mode is selected, RESET must remain asserted for 16 PCLK2:1 cycles before being deasserted in order to guarantee correct processor initialization. When the $1-\mathrm{x}$ clock mode is selected, RESET must remain asserted for 10,000 PCLK2:1 cycles before being deasserted in order to guarantee correct initialization. The CLKMODE pin selects 1-x or 2-x input clock division of the CLKIN pin. <br> The processor's Hold Acknowledge bus state functions while the chip is reset. If the processor's bus is in the Hold Acknowledge state when RESET is asserted, the processor will internally reset, but maintains the Hold Acknowledge state on external pins until the Hold request is removed. If a hold request is made while the processor is in the reset state, the processor bus grants HOLDA and enters the Hold Acknowledge state. |
| FAIL | $\begin{gathered} \mathbf{O} \\ \mathrm{S} \\ H(Q) \\ R(0) \end{gathered}$ | FAIL indicates failure of the processor's self-test performed at initialization. When RESET is deasserted and the processor begins initialization, the FAIL pin is asserted. An internal self-test is performed as part of the initialization process. If this self-test passes, the FAIL pin is deasserted otherwise it remains asserted. The FAIL pin is reasserted while the processor performs an external bus self-confidence test. If this self-test passes, the processor deasserts the FAIL pin and branches to the user's initialization routine; otherwise the FAIL pin remains asserted. Internal self-test and the use of the FAIL pin can be disabled with the STEST pin. |

Table 3. 80960CF Pin Description—Processor Control Signals (Continued)

| Name | Type | Description |
| :---: | :---: | :---: |
| STEST | $\begin{gathered} \hline \mathbf{I} \\ \mathrm{S}(\mathrm{~L}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \end{gathered}$ | SELF TEST causes the processor's internal self-test feature to be enabled or disabled at initialization. STEST is read on the rising edge of RESET. When asserted, the processor's internal self-test and external bus confidence tests are performed during processor initialization. When deasserted, only the external bus confidence tests are performed during initialization. |
| ONCE | $\begin{gathered} \text { I } \\ \text { A(L) } \\ \text { H(Z) } \\ \text { R(Z) } \end{gathered}$ | ON CIRCUIT EMULATION causes all outputs to be floated when asserted. ONCE is continuously sampled while RESET is low, and is latched on the rising edge of RESET. To place the processor in the ONCE state: <br> (1) assert RESET and ONCE (order does not matter) <br> (2) wait for at least 16 CLKIN periods in $2-x$ mode, or 10,000 CLKIN periods in $1-\mathrm{x}$ mode, after $\mathrm{V}_{\mathrm{CC}}$ and CLKIN are within operating specifications <br> (3) deassert RESET <br> (4) wait at least 32 CLKIN periods <br> (The processor is now latched in the ONCE state as long as $\overline{\operatorname{RESET}}$ is high.) <br> To exit the ONCE state, bring $\mathrm{V}_{C C}$ and CLKIN to operating conditions, then assert $\overline{\text { RESET }}$ and bring ONCE high prior to deasserting RESET. <br> CLKIN must operate within the specified operating conditions of the processor until step 4 above is completed. The CLKIN may then be changed to DC to achieve the lowest possible ONCE mode leakage current. <br> ONCE can be used by emulator products or for board testers to effectively make an installed processor transparent in the board. |
| CLKIN | $\begin{gathered} \hline \mathbf{I} \\ \mathrm{A}(\mathrm{E}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \\ \hline \end{gathered}$ | CLOCK INPUT is an input for the external clock needed to run the processor. The external clock is internally divided as prescribed by the CLKMODE pin to produce PCLK2:1. |
| CLKMODE | $\begin{gathered} \text { I } \\ \text { A(L) } \\ \text { H(Z) } \\ \text { R(Z) } \end{gathered}$ | CLOCK MODE selects the division factor applied to the external clock input (CLKIN). When CLKMODE is high, CLKIN is divided by one to create PCLK2:1 and the processor's internal clock. When CLKMODE is low, CLKIN is divided by two to create PCLK2:1 and the processor's internal clock. CLKMODE should be tied high or low in a system, as the clock mode is not latched by the processor. If left unconnected, the processor internally pulls the CLKMODE pin low, enabling the $2-x$ clock mode. |
| $\begin{aligned} & \text { PCLK2 } \\ & \text { PCLK1 } \end{aligned}$ | $\begin{gathered} \mathbf{0} \\ S \\ H(Q) \\ R(Q) \end{gathered}$ | PROCESSOR OUTPUT CLOCKS provide a timing reference for all inputs and outputs of the processor. All inputs and output timings are specified in relation to PCLK2 and PCLK1. PCLK2 and PCLK1 are identical signals. Two output pins are provided to allow flexibility in the system's allocation of capacitive loading on the clock. PCLK2:1 may also be connected at the processor to form a single clock signal. |
| $\mathrm{v}_{\text {SS }}$ | - | GROUND connections consist of 24 pins which must be connected externally to a $V_{S S}$ board plane. |
| $\mathrm{V}_{\mathrm{Cc}}$ | - | POWER connections consist of 24 pins which must be connected externally to a $\mathrm{V}_{\mathrm{CC}}$ board plane. |
| $\mathrm{V}_{\text {CCPLL }}$ | - | $\mathrm{V}_{\text {CCPLL }}$ is a separate $\mathrm{V}_{\text {CC }}$ supply pin for the phase lock loop used in 1 x clock mode. Connecting a simple low pass filter to $\mathrm{V}_{\text {CCPLL }}$ may help reduce clock jitter ( $\mathrm{T}_{\mathrm{CP}}$ ) in noisy environments. Otherwise, $\mathrm{V}_{\mathrm{CCPLL}}$ should be connected to $\mathrm{V}_{\mathrm{CC}}$. |
| N/C | - | NO CONNECT pins must not be connected in a system. |

Table 4. 80960CF Pin Description—DMA and Interrupt Unit Control Signals

| Name | Type | Description |
| :---: | :---: | :---: |
| $\overline{\text { DREQ3 }}$ <br> $\overline{\text { DREQ2 }}$ <br> $\overline{\text { DREQ1 }}$ <br> $\overline{\text { DREQ0 }}$ | $\begin{gathered} \text { I } \\ \mathrm{A}(\mathrm{~L}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \end{gathered}$ | DMA REQUEST causes a DMA transfer to be requested. Each of the four signals request a transfer on a single channel. DREQ0 requests channel 0, DREQ1 requests channel 1, etc. When two or more channels are requested simultaneously, the channel with the highest priority is serviced first. Channel priority mode is programmable. |
| $\overline{\text { DACK3 }}$ $\overline{\text { DACK2 }}$ $\overline{\overline{D A C K 1}}$ $\overline{\text { DACK }}$ | $\begin{gathered} 0 \\ S \\ H(1) \\ R(1) \end{gathered}$ | DMA ACKNOWLEDGE indicates that a DMA transfer is being executed. Each of the four signals acknowledge a transfer for a single channel. DACKO acknowledges channel 0, $\overline{\text { DACK1 }}$ acknowledges channel 1, etc. $\overline{\text { DACK3: }} 0$ are asserted when the requesting device of a DMA is accessed. |
| EOP3/TC3 <br> EOP2/TC2 <br> EOP1/TC1 <br> EOP0/TC0 | $\begin{gathered} \text { I / O } \\ A(L) \\ H(Z / Q) \\ R(Z) \end{gathered}$ | END OF PROCESS/TERMINAL COUNT can be programmed as either an input ( $\overline{\mathrm{EOP} 3: 0}$ ) or as an output (TC3:0), but not both. Each pin is individually programmable. When programmed as an input, EOPx causes the termination of a current DMA transfer for the channel corresponding to the EOPx pin. $\overline{\mathrm{EOPO}}$ corresponds to channel 0 , EOP1 corresponds to channel 1 , etc. When a channel is configured for source and destination chaining, the EOP pin for that channel causes termination of only the current buffer transferred and causes the next buffer to be transferred. EOP3:0 are asynchronous inputs. <br> When programmed as an output, the channel's $\overline{T C x}$ pin indicates that the channel byte count has reached 0 and a DMA has terminated. $\overline{\text { TCx }}$ is driven with the same timing as $\overline{\text { DACKx }}$ during the last DMA transfer for a buffer. If the last bus request is executed as multiple bus accesses, $\overline{\mathrm{TCx}}$ remains asserted for the entire bus request. |
| $\begin{aligned} & \hline \overline{\text { XINT7 }} \\ & \overline{\text { XINT6 }} \\ & \hline \overline{\text { XINT5 }} \\ & \hline \overline{\text { XINT4 }} \\ & \hline \overline{\text { XINT3 }} \\ & \hline \overline{\text { XINT2 }} \\ & \hline \overline{\text { XINT1 }} \\ & \hline \text { XINT0 } \end{aligned}$ | $\begin{gathered} \text { I } \\ A(E / L) \\ H(Z) \\ R(Z) \end{gathered}$ | EXTERNAL INTERRUPT PINS cause interrupts to be requested. These pins can be configured in three modes. <br> In Dedicated Mode, each pin is a dedicated external interrupt source. Dedicated inputs can be individually programmed to be level (low) or edge (falling) activated. In Expanded Mode, the 8 pins act together as an 8-bit vectored interrupt source. The interrupt pins in this mode are level activated. Since the interrupt pins are active low, the vector number requested is the one's complement of the positive logic value place on the port. This eliminates glue logic to interface to combinational priority encoders which output negative logic. <br> In Mixed Mode, XINT7:5 are dedicated sources and $\overline{\text { XINT4:0 }}$ act as the 5 most significant bits of an expanded mode vector. The least significant bits are set to 010 internally. |
| $\overline{\text { NMI }}$ | $\begin{gathered} \text { I } \\ \mathrm{A}(\mathrm{E}) \\ \mathrm{H}(\mathrm{Z}) \\ \mathrm{R}(\mathrm{Z}) \end{gathered}$ | NON-MASKABLE INTERRUPT causes a non-maskable interrupt event to occur. $\overline{\mathrm{NMI}}$ is the highest priority interrupt recognized. $\overline{\mathrm{NMI}}$ is an edge (falling) activated source. |

### 3.3. 80960CF Pinout

### 3.3.1 80960CF PGA PINOUT

Tables 5 and 6 list the 80960CF pin names with package location. Figure 4-a depicts the complete

80960CF pinout as viewed from the top side of the component (i.e., pins facing down). Figure 4b shows the complete 80960CF pinout as viewed from the pin-side of the package (i.e., pins facing up). See Section 4.0, Electrical Specifications for specifications and recommended connections.

Table 5. PGA Pin Name with Package Location (Signal Order)


Table 6. PGA Pin Name with Package Location (Pin Order)

| Address Bus | Data Bus | Bus Control | Processor Control | 1/0 |
| :---: | :---: | :---: | :---: | :---: |
| Location . . Name | Location . . Name | Location . . Name | Location . . . . Name | Location . . Name |
| A01..........NC | C01 .......... D3 | G01 ......... . . 9 | M01 .......... D16 | R01 ........ . D24 |
| A02 ........ $\overline{\text { FAIL }}$ | C02 ......... ${ }^{\text {D } 1}$ | G02 ........ $\mathrm{V}_{\mathrm{CC}}$ | M02 ......... $\mathrm{V}_{\mathrm{CC}}$ | R02 ........ . . 227 |
| A03 ..........NC | C03 . . . . . $\overline{\text { ONCE }}$ | G03 ........ $\mathrm{V}_{\text {SS }}$ | M03.......... $\mathrm{V}_{\text {SS }}$ | R03 ........ ${ }^{\text {D } 31}$ |
| A04..........NC | C04..........NC | G15 ........ $\mathrm{V}_{\text {SS }}$ | M15......... $\mathrm{V}_{\text {SS }}$ | R04...... BTERM |
| A05 ..........NC | C05.........NC | G16.........A7 | M16 ......... $\mathrm{V}_{\text {CC }}$ | R05 .......HOLD |
| A06 ..... $\overline{\text { DREQ1 }}$ | $\mathrm{C} 06 \ldots \ldots . . \mathrm{V}_{\mathrm{CC}}$ | G17 .........A8 | M17..........A14 | R06 ........ $\overline{\text { ADS }}$ |
| A07 ..... $\overline{\text { DREQ3 }}$ | C07 ........ $\mathrm{V}_{\text {SS }}$ |  |  | R07........ $\mathrm{V}_{\text {CC }}$ |
| A08 ..... $\overline{\text { DACK1 }}$ | $\mathrm{C} 08 \ldots \ldots . . \mathrm{V}_{\text {SS }}$ | H01 ........ D11 | N01.......... D17 | R08 ........ $\mathrm{V}_{\text {CC }}$ |
| A09 ..... $\overline{\text { DACK2 }}$ | C09 ........ $\mathrm{V}_{\text {SS }}$ | H02 ........ ${ }^{\text {D10 }}$ | N02.......... . D18 | R09 ........ $\overline{\text { BEO }}$ |
| A10 .... $\overline{\text { DACK3 }}$ | $\mathrm{C} 10 \ldots \ldots . . \mathrm{V}_{\text {SS }}$ | H03 ........ $\mathrm{V}_{\text {SS }}$ | N03......... $\mathrm{V}_{\text {CC }}$ | $\mathrm{R} 10 \ldots \ldots . . \mathrm{V}_{\text {CC }}$ |
| A11...EOP/TC0 | $\mathrm{C} 11 \ldots \ldots . . \mathrm{V}_{\text {SS }}$ | H15 ........ $\mathrm{V}_{\text {SS }}$ | $\mathrm{N} 15 \ldots \ldots \ldots . \mathrm{V}_{\text {CC }}$ | $\mathrm{R} 11 \ldots \ldots . . \mathrm{V}_{\text {CC }}$ |
| A12... $\mathrm{EOP} / \mathrm{TC} 1$ | $\mathrm{C} 12 \ldots . . . . \mathrm{V}_{\text {SS }}$ | H16........ $\mathrm{V}_{\text {CC }}$ | N16..........A16 | R12...... $\overline{\text { DMA }}$ |
| A13 ... $\overline{\text { EOP/TC2 }}$ | C13...... CLKIN | H17 .......... A9 | N17............A15 | R13 ....... BREQ |
| A14 ... EOP/TC3 | C14...CLKMODE |  |  | R14......... A29 |
| A15 ...... $\overline{\text { XINT1 }}$ | C15 ...... $\overline{\text { XINT4 }}$ | J01 ........ D12 | P01 ........... D19 | R15 ......... A26 |
| A16.......RESET | C16...... $\overline{\text { XINT6 }}$ | J02 ........ $\mathrm{V}_{\mathrm{CC}}$ | P02.......... . D20 | R16......... A23 |
| A17 ...... $\overline{\text { XINT2 }}$ | C17 ...... $\overline{\text { XINT7 }}$ | J03 ........ $\mathrm{V}_{\text {SS }}$ | P03 .......... ${ }^{\text {D } 22}$ | R17........A22 |
|  |  | J15 ........ $\mathrm{V}_{\text {SS }}$ | P15........... A20 |  |
| B01 ...... $\overline{\text { BOFF }}$ | D01 ......... D5 | J16 ........ $\mathrm{V}_{\text {CC }}$ | P16..........A19 | S01 ........ D25 |
| B02 ..... STEST | D02 .......... D2 | J17 ........A10 | P17..........A17 | S02 ........ D29 |
| B03..........NC | D03..........NC |  |  | S03 .... . READY |
| B04..........NC | D15........ $\overline{\text { NMI }}$ | K01 ........ D13 | Q01...........D21 | S04..... HOLDA |
| B05..... $\overline{\text { DREQ0 }}$ | D16..........A2 | K02 ........ $\mathrm{V}_{\mathrm{CC}}$ | Q02........... D23 | S05 ........ $\overline{\text { BE3 }}$ |
| B06..... ${ }^{\text {DREQ2 }}$ | D17 ......... A3 | K03 ........ $\mathrm{V}_{\text {SS }}$ | Q03........... D26 | S06........ $\overline{\mathrm{BE} 2}$ |
| B07 ........ $\mathrm{V}_{\text {cC }}$ |  | K15 ........ $\mathrm{V}_{\text {SS }}$ | Q04.......... D28 | S07 ........ $\overline{\mathrm{BE}} 1$ |
| B08 ..... $\overline{\text { DACKO }}$ | E01 ......... D7 | K16........ $\mathrm{V}_{\mathrm{CC}}$ | Q05.......... D30 | S08 ...... $\overline{\text { BLAST }}$ |
| B09 ........ $\mathrm{V}_{\mathrm{CC}}$ | E02 .......... ${ }^{\text {D } 4}$ | K17 .........A11 | Q06.......... $\mathrm{V}_{\mathrm{CC}}$ | S09 ....... $\overline{\text { DEN }}$ |
| B10 ..... $\mathrm{V}_{\text {CCPLL }}$ | E03 ......... D0 |  | Q07.......... $\mathrm{V}_{\text {SS }}$ | S10 ......W/ $/ \overline{\mathrm{R}}$ |
| B11........ $\mathrm{V}_{\mathrm{CC}}$ | E15 ........ $\mathrm{V}_{\mathrm{CC}}$ | L01 ........ D15 | Q08 .......... $\mathrm{V}_{\text {SS }}$ | S11.......DT/ $\overline{\mathrm{R}}$ |
| B12 ........ $\mathrm{V}_{\mathrm{CC}}$ | E16.........A4 | L02 ........ D14 | Q09 ......... $\mathrm{V}_{\text {SS }}$ | S12....... $\overline{\text { WAIT }}$ |
| B13 ..... PCLK2 | E17 ..........A5 | L03 ........ $\mathrm{V}_{\text {SS }}$ | Q10.......... $\mathrm{V}_{\text {SS }}$ | S13....... $\mathrm{D} / \overline{\mathrm{C}}^{\text {chen }}$ |
| B14 ......PCLK1 |  | L15 ........ $\mathrm{V}_{\text {SS }}$ | Q11.......... $\mathrm{V}_{\text {SS }}$ | S14...... $\overline{\text { LOCK }}$ |
| B15 ...... $\overline{\text { XINT0 }}$ | F01 ......... D8 | L16 .........A13 | Q12 ......... SUP $^{\text {Q }}$ | S15 .........A31 |
| B16 ...... $\overline{\text { XINT3 }}$ | F02 ......... . 6 | L17 .........A12 | Q13........... A30 | S16........ A27 |
| B17 ....... XINT5 | F03 ........ $\mathrm{V}_{\text {CC }}$ |  | Q14...........A28 | S17 ........A25 |
|  | F15 ........ $\mathrm{V}_{\text {SS }}$ |  | Q15...........A24 |  |
|  | F16........ $\mathrm{V}_{\mathrm{CC}}$ |  | Q16...........A21 |  |
|  | F17 .......... A6 |  | Q17...........A18 |  |



Figure 4a. 80960CF PGA Pinout (View from Top Side)


Figure 4b. 80960CF PGA Pinout (View from Bottom Side)

### 3.4. Mechanical Data

### 3.4.1 CERAMIC PGA PACKAGE



| Family: Ceramic Pin Grid Array Package |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | ---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol | Millimeters |  |  | Inches |  |  |  |  |  |  |  |  |  |  |
|  | Min | Max | Notes | Min | Max | Notes |  |  |  |  |  |  |  |  |
| A | 3.56 | 4.57 |  | 0.140 | 0.180 |  |  |  |  |  |  |  |  |  |
| $\mathrm{~A}_{1}$ | 0.64 | 1.14 | SOLID LID | 0.025 | 0.045 | SOLID LID |  |  |  |  |  |  |  |  |
| $\mathrm{A}_{2}$ | 23 | 0.30 | SOLID LID | 0.110 | 0.140 | SOLID LID |  |  |  |  |  |  |  |  |
| $\mathrm{A}_{3}$ | 1.14 | 1.40 |  | 0.045 | 0.055 |  |  |  |  |  |  |  |  |  |
| B | 0.43 | 0.51 |  | 0.017 | 0.020 |  |  |  |  |  |  |  |  |  |
| D | 44.07 | 44.83 |  | 1.735 | 1.765 |  |  |  |  |  |  |  |  |  |
| $\mathrm{D}_{1}$ | 40.51 | 40.77 |  | 1.595 | 1.605 |  |  |  |  |  |  |  |  |  |
| $\mathrm{e}_{1}$ | 2.29 | 2.79 |  | 0.090 | 0.110 |  |  |  |  |  |  |  |  |  |
| L | 2.54 | 3.30 |  | 0.100 | 0.130 |  |  |  |  |  |  |  |  |  |
| N | 168 |  |  |  |  |  |  |  | 168 |  |  |  |  |  |
| $\mathrm{~S}_{1}$ | 1.52 | 2.54 |  | 0.060 | 0.100 |  |  |  |  |  |  |  |  |  |
| ISSUE | IWS REV X 7/15/88 |  |  |  |  |  |  |  |  |  |  |  |  |  |

Figure 5. 168-Lead Ceramic PGA Package Dimensions

Table 7. Ceramic PGA Package Dimension Symbols

| Letter or <br> Symbol | Description of Dimensions |
| :---: | :--- |
| A | Distance from seating plane to highest point of body |
| $\mathrm{A}_{1}$ | Distance between seating plane and base plane (lid) |
| $\mathrm{A}_{2}$ | Distance from base plane to highest point of body |
| $\mathrm{A}_{3}$ | Distance from seating plane to bottom of body |
| B | Diameter of terminal lead pin |
| D | Largest overall package dimension of length |
| $\mathrm{D}_{1}$ | A body length dimension, outer lead center to outer lead center |
| $\mathrm{e}_{1}$ | Linear spacing between true lead position centerlines |
| L | Distance from seating plane to end of lead |
| $\mathrm{S}_{1}$ | Other body dimension, outer lead center to edge of body |

## NOTES:

1. Controlling dimension: millimeter
2. Dimension " $e_{1}$ " ("e") is non-cumulative.
3. Seating plane (standoff) is defined by P.C. board hole size: $0.0415-0.0430$ inch
4. Dimensions " $B$ ", " $B_{1}$ " and " $C$ " are nominal.
5. Details of Pin 1 identifier are optional.

### 3.5. Package Thermal Specifications

The 80960 CF is specified for operation when $T_{C}$ (the case temperature) is within the range of $-40^{\circ} \mathrm{C}-+110^{\circ} \mathrm{C} . \mathrm{T}_{\mathrm{C}}$ may be measured in any environment to determine whether the 80960CF is within specified operating range. The case temperature is measured at the center of the top surface, opposite the pins. Refer to Figure 7.
$T_{A}$ (the ambient temperature) can be calculated from $\theta_{\mathrm{CA}}$ (thermal resistance from case to ambient) with the following equation:

$$
\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{C}}-\mathrm{P}^{*} \theta_{\mathrm{CA}}
$$

Table 8 shows the maximum $\mathrm{T}_{\mathrm{A}}$ allowable (without exceeding $\mathrm{T}_{\mathrm{C}}$ ) at various airflows and operating frequencies (fPCLK).

Note that $T_{A}$ is greatly improved by attaching fins or a heat sink to the package. $P$ (the maximum power consumption) is calculated by using the typical $I_{C C}$ as tabulated in Section 4.4, DC Specifications, and $\mathrm{V}_{\mathrm{CC}}$ of 5 V .

Table 8. Maximum $\mathrm{T}_{\mathrm{A}}$ at Various Airflows In ${ }^{\circ} \mathrm{C}$ (PGA Package Only)

|  |  | Airflow-ft/min (m/sec) |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathbf{f}_{\mathrm{PCLK}}$ (MHz) | $\begin{gathered} 0 \\ (0) \\ \hline \end{gathered}$ | $\begin{gathered} 200 \\ (1.01) \\ \hline \end{gathered}$ | $\begin{gathered} \hline 400 \\ (2.03) \\ \hline \end{gathered}$ | $\begin{gathered} 600 \\ (3.04) \\ \hline \end{gathered}$ | $\begin{gathered} 800 \\ (4.06) \\ \hline \end{gathered}$ | $\begin{array}{r} 1000 \\ (5.07) \\ \hline \end{array}$ |
| $\begin{aligned} & \mathrm{T}_{\mathrm{A}} \\ & \text { with } \\ & \text { Heat Sink* } \end{aligned}$ | $\begin{aligned} & 33 \\ & 25 \\ & 16 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 38 \\ & 50 \\ & 63 \\ & \hline \end{aligned}$ | $\begin{aligned} & 57 \\ & 65 \\ & 74 \end{aligned}$ | $\begin{aligned} & 74 \\ & 79 \\ & 84 \\ & \hline \end{aligned}$ | $\begin{aligned} & 76 \\ & 81 \\ & 86 \\ & \hline \end{aligned}$ | $\begin{aligned} & 81 \\ & 85 \\ & 89 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 84 \\ & 87 \\ & 90 \\ & \hline \end{aligned}$ |
| $\mathrm{T}_{\mathrm{A}}$ without Heat Sink | $\begin{aligned} & 33 \\ & 25 \\ & 16 \\ & \hline \end{aligned}$ | $\begin{aligned} & 18 \\ & 34 \\ & 51 \\ & \hline \end{aligned}$ | $\begin{aligned} & 33 \\ & 46 \\ & 60 \\ & \hline \end{aligned}$ | $\begin{aligned} & 47 \\ & 57 \\ & 68 \end{aligned}$ | $\begin{aligned} & 57 \\ & 65 \\ & 74 \\ & \hline \end{aligned}$ | $\begin{aligned} & 66 \\ & 72 \\ & 80 \\ & \hline \end{aligned}$ | $\begin{aligned} & 67 \\ & 74 \\ & 81 \\ & \hline \end{aligned}$ |

* 0.285 " high unidirectional heat sink (Al alloy 6061,50 mil fin width, 150 mil center-to-center fin spacing).


NOTES:

1. This table applies to 80960 CF PGA plugged into socket or soldered directly into board.
2. $\theta_{\mathrm{JA}}=\theta_{\mathrm{JC}}+\theta_{\mathrm{CA}}$.
3. $\theta_{\mathrm{JJ} \text {-CAP }}=4^{\circ} \mathrm{C} / \mathrm{W}$ (approx.)
$\theta_{\mathrm{J} \text {-PIN }}=4^{\circ} \mathrm{C} / \mathrm{W}$ (inner pins) (approx.)
$\theta_{\mathrm{J}-\mathrm{PIN}}=8^{\circ} \mathrm{C} / \mathrm{W}$ (outer pins) (approx.)

* 0.285 " high unidirectional heat sink (Al alloy 6061, 50 mil fin width, 150 mil center-to-center fin spacing).

Figure 6. 80960CF PGA Package Thermal Characteristics


Figure 7. Measuring 80960CF PGA Case Temperature

### 3.6 Stepping Register Information

Upon Reset, Register GO contains die stepping information. The following figure shows how G0 is configured. The most significant byte contains an ASCII 0 . The upper middle byte contains an ASCII C. The lower middle byte contains an ASCII F. The least significant byte contains the stepping number in ASCII. GO retains this information until it is written over by the user program.

Table 9 contains a cross reference of the number in the least significant byte of register GO to the die stepping number.

| $\begin{aligned} & \text { ASCII } \\ & \text { DECIMAL } \end{aligned}$ | 00 | 43 | 46 | Stepping Number |
| :---: | :---: | :---: | :---: | :---: |
|  | 0 | C | F | Stepping Number |
|  | MSB |  |  | LSB |

Figure 8. Register GO
Table 9. Die Stepping Cross Reference

| Go Least <br> Significant Byte | Die Stepping |
| :---: | :---: |
| 01 | A |
| 02 | B |
| 03 | C |
| 04 | D |
| 05 | E |

SPECIAL ENVIRONMENT 80960CF-30, -25,-16

### 3.7 Suggested Sources for 80960CF Accessories

The following are some suggested sources of accessories for the 80960CF. They are neither an endorsement of any kind, nor a warranty of the performance of any of the listed products and/or companies.

## Sockets

1. 3M Textool Test and Interconnection Products

Department
P.O. Box 2963

Austin, TX 78769-2963
2. Augat, Inc.

Interconnection Products Group
33 Perry Avenue
P.O. Box 779

Attleboro, MA 02703
(508) 222-2202
3. Concept Manufacturing Inc.
(Decoupling Sockets)
43024 Christy Street
Fremont, CA 94538
(415) 651-3804

## Heat Sinks/Fins

1. Thermalloy, Inc.

2021 West Valley View Lane
Dallas, TX 75381-0839
(214) 243-4321
2. $E G \& G$ Division 60 Audubon Road
Wakefield, MA 01880
(617) 245-5900

### 4.0 ELECTRICAL SPECIFICATIONS

### 4.1 Absolute Maximum Ratings

| Parameter | Maximum Rating |
| :--- | :---: |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Case Temperature Under Bias $(2)$ | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Supply Voltage wrt. VSS | -0.5 V to +6.5 V |
| Voltage on Other pins wrt $\mathrm{V}_{\mathrm{SS}}$ | -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ |

NOTICE: This data sheet contains information on products in the sampling and initial production phases of development. It is valid for the devices indicated in the revision history. The specifications are subject to change without notice.
*WARNING: Stressing the device beyond the "Absolute Maximum Ratings" may cause permanent damage. These are stress ratings only. Operation beyond the 'Operating Conditions" is not recommended and extended exposure beyond the "Operating Conditions" may affect device reliability.

### 4.2. Operating Conditions

| Operating Conditions (80960CF-33, -25, -16) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol | Parameter |  | Min | Max | Units | Notes |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply Voltage | 80960CF-30 80960CF-25 80960CF-16 | $\begin{aligned} & 4.75 \\ & 4.50 \\ & 4.50 \end{aligned}$ | $\begin{aligned} & 5.25 \\ & 5.50 \\ & 5.50 \\ & \hline \end{aligned}$ | V |  |
| fCLK2x | Input Clock Frequency (2-x Mode) | 80960CF-30 <br> 80960CF-25 <br> 80960CF-16 | $\begin{aligned} & 0 \\ & 0 \\ & 0 \end{aligned}$ | $\begin{gathered} 60.6 \\ 50 \\ 32 \end{gathered}$ | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{MHz} \\ & \mathrm{MHz} \end{aligned}$ |  |
| $\mathrm{f}_{\text {CLK1x }}$ | Input Clock Frequency (1-x Mode) | 80960CF-30 <br> 80960CF-25 <br> 80960CF-16 | $\begin{aligned} & 8 \\ & 8 \\ & 8 \end{aligned}$ | $\begin{gathered} 30.3 \\ 25 \\ 16 \end{gathered}$ | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{MHz} \\ & \mathrm{MHz} \\ & \hline \end{aligned}$ | (1) |
| $\mathrm{T}_{\mathrm{C}}$ | Case Temperature Under Bias 80960CF-30, -25, -16 | PGA Package | -40 | +110 | ${ }^{\circ} \mathrm{C}$ |  |

NOTES:
(1) When in the $1-x$ input clock mode, CLKIN is an input to an internal phase-locked loop and must maintain a minimum frequency of 8 MHz for proper processor operation. However, in the $1-x$ Mode, CLKIN may still be stopped when the processor either is in a reset condition or is reset. If CLKIN is stopped, the specified RESET low time must be provided once CLKIN restarts and has stabilized.
(2) Case temperatures are "Instant On".

### 4.3 Recommended Connections

Power and ground connections must be made to multiple $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{SS}}$ (GND) pins. Every 80960CFbased circuit board should include power ( $\mathrm{V}_{\mathrm{CC}}$ ) and ground $\left(\mathrm{V}_{\mathrm{SS}}\right)$ planes for power distribution. Every $V_{\text {Cc }}$ pin must be connected to the power plane, and every $\mathrm{V}_{\text {SS }}$ pin must be connected to the ground plane. Pins identified as "N.C." must not be connected in the system.

Liberal decoupling capacitance should be placed near the 80960CF. The processor can cause transient power surges when its numerous output buffers transition, particularly when connected to large capacitive loads.

Low inductance capacitors and interconnects are recommended for best high frequency electrical performance. Inductance can be reduced by shortening board traces between the processor and decoupling capacitors as much as possible. Capacitors specifically designed for PGA packages will offer the lowest possible inductance.

For reliable operation, always connect unused inputs to an appropriate signal level. In particular, any unused interrupt ( $\overline{\mathrm{XINT}}, \overline{\mathrm{NMI}}$ ) or DMA ( $\overline{\mathrm{DREQ}}$ ) input should be connected to $\mathrm{V}_{\mathrm{CC}}$ through a pull-up resistor, as should BTERM if not used. Pull-up resistors should be in the range of $20 \mathrm{~K} \Omega$ for each pin tied high. If $\overline{R E A D Y}$ or HOLD are not used, the unused input should be connected to ground. N.C. pins must always remain unconnected. Refer to the i960 CA Microprocessor Reference Manual for more information.

SPECIAL ENVIRONMENT 80960CF-30, -25, -16

### 4.4. DC Specifications

DC Characteristics
(80960CF-30, -25, -16 under the conditions described in Section 4.2, Operating Conditions.)

| Symbol | Parameter | Min | Max | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IL}}$ | Input Low Voltage for all pins except RESET | -0.3 | 0.8 | V |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Input High Voltage for all pins except RESET | 2.0 | $\mathrm{V}_{\mathrm{CC}}+0.3$ | V |  |
| VoL | Output Low Voltage |  | 0.45 | V | $\mathrm{IOL}^{2}=5 \mathrm{~mA}$ |
| $\mathrm{V}_{\mathrm{OH}}$ | $\begin{array}{\|ll} \hline \text { Output High Voltage } & \begin{array}{l} \mathrm{I} \\ \mathrm{OH} \end{array}=-1 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-200 \mu \mathrm{~A} \end{array}$ | $\begin{gathered} 2.4 \\ V_{C C}-0.5 \end{gathered}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |  |
| $\mathrm{V}_{\text {ILR }}$ | Input Low Voltage for RESET | - 0.3 | 1.5 | V |  |
| $\mathrm{V}_{\text {IHR }}$ | Input High Voltage for RESET | 3.5 | $\mathrm{V}_{\mathrm{CC}}+0.3$ | V |  |
| ILI1 | Input Leakage Current for each pin except: <br> BTERM, ONCE, $\overline{\text { DREQ3:0 }}$, STEST, <br> EOP3:0/TC3:0, NMI, XINT7:0, <br> $\overline{\text { READY, }}$ HOLD, $\overline{B O F F}$, CLKMODE |  | $\pm 15$ | $\mu \mathrm{A}$ | $\mathrm{V} \leq \mathrm{V}_{\text {IN }} \leq \mathrm{V}_{\text {CC }}$ (1) |
| $\mathrm{l}_{12}$ | Input Leakage Current for: <br> BTERM, $\overline{O N C E}, \overline{D R E Q 3: O}, ~ S T E S T, ~$ <br> $\overline{\mathrm{EOP} 3: 0} / \overline{\mathrm{TC3}} \mathbf{0}, \overline{\mathrm{NMI}, ~ \overline{X I N T 7: 0}}, \overline{\mathrm{BOFF}}$ | 0 | -325 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=0.45 \mathrm{~V}$ (2) |
| lı13 | Input Leakage Current for: READY, HOLD, CLKMODE | 0 | 500 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=2.4 \mathrm{~V}(3)$ |
| ILO | Output Leakage Current |  | $\pm 15$ | $\mu \mathrm{A}$ | $0.45 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq \mathrm{V}_{\text {CC }}$ |
| Icc | Supply Current (80960CF-30) <br> Icc Max <br> ICC Typ |  | $\begin{gathered} 1150 \\ 960 \end{gathered}$ | mA | $\begin{aligned} & \text { (4) } \\ & \text { (5) } \end{aligned}$ |
| $\mathrm{I}_{\mathrm{cc}}$ | Supply Current (80960CF-25) Icc Max Icc Typ |  | $\begin{aligned} & 950 \\ & 775 \end{aligned}$ | mA | $\begin{aligned} & \text { (4) } \\ & (5) \end{aligned}$ |
| Icc | Supply Current (80960CF-16) Icc Max Icc Typ |  | $\begin{aligned} & 750 \\ & 575 \end{aligned}$ | mA | (4) <br> (5) |
| lonce | ONCE-mode Supply Current |  | 150 | mA |  |
| $\mathrm{ClN}_{\text {IN }}$ | Input Capacitance for: <br> CLKIN, RESET, ONCE, <br> $\overline{\text { READY, }}$, HOLD, $\overline{\text { DREQ3: }}, \overline{\text { BOFF }}$ $\overline{\text { XINT7:0 }}, \overline{\text { NMI, }}, \overline{B T E R M}, ~ C L K M O D E ~$ | 0 | 12 | pF | $\mathrm{F}_{\mathrm{C}}=1 \mathrm{MHz}$ |
| Cout | Output Capacitance of each output pin |  | 12 | pF | $\mathrm{F}_{\mathrm{C}}=1 \mathrm{MHz}$, (6) |
| $\mathrm{C}_{1 / 0}$ | I/O Pin Capacitance |  | 12 | pF | $\mathrm{F}_{\mathrm{C}}=1 \mathrm{MHz}$ |

## NOTES:

(1) No Pull-up or pull-down.
(2) These pins have internal pullup resistors.
(3) These pins have internal pulldown resistors.
(4) Measured at worst case frequency, $\mathrm{V}_{\mathrm{CC}}$ and temperature, with device operating and outputs loaded to the test conditions described in Section 4.5.1, AC Test Conditions.
(5) I Icc Typical is not tested.
(6) Output Capacitance is the capacitive load of a floating output
(7) CLKMODE pin has a pulldown resistor only when ONCE pin is deasserted.

### 4.5 AC Specifications

AC Characteristics - 80960CF-30
(80960CF-30 only, under the conditions described in Section 4.2, Operating Conditions and Section 4.5.1, AC Test Conditions.) See notes which follow this table.

| Symbol | Parameter |  | Min | Max | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CLOCK(10) |  |  |  |  |  |  |
| $\mathrm{T}_{\mathrm{F}}$ | CLKIN Frequency |  | 0 | 60.6 | MHz | (1) |
| $\mathrm{T}_{\mathrm{C}}$ | CLKIN Period | In 1-x Mode (f $\mathrm{f}_{\mathrm{CK}} 1 \mathrm{x}$ ) <br> In 2-x Mode (fCLK2x) | $\begin{gathered} 33 \\ 16.5 \end{gathered}$ | $\begin{gathered} 125 \\ \infty \end{gathered}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \\ \hline \end{gathered}$ |
| TCS | CLKIN Period Stability | In 1-x Mode (fCLK1x) |  | $\pm 0.1 \%$ | $\Delta$ | $(1,13)$ |
| $\mathrm{T}_{\mathrm{CH}}$ | CLKIN High Time | In 1-x Mode (f CLK1x) <br> In 2-x Mode (fCLK2x) | $\begin{aligned} & 6 \\ & 6 \end{aligned}$ | $\begin{gathered} 62.5 \\ \infty \end{gathered}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \\ \hline \end{gathered}$ |
| $\mathrm{T}_{\mathrm{CL}}$ | CLKIN Low Time | In 1-x Mode (f CLK1x) <br> In 2-x Mode (f $\mathrm{f}_{\mathrm{CLK}}$ 2x) | $\begin{aligned} & 6 \\ & 6 \end{aligned}$ | $\begin{gathered} 62.5 \\ \infty \end{gathered}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \\ \hline \end{gathered}$ |
| TCR | CLKIN Rise Time |  | 0 | 6 | ns | (1) |
| TCF | CLKIN Fall Time |  | 0 | 6 | ns | (1) |
| OUTPUT CLOCKS ${ }^{(9)}$ |  |  |  |  |  |  |
| $\mathrm{T}_{\mathrm{CP}}$ | CLKIN to PCLK2:1 Delay | In 1-x Mode (f $\mathrm{fLK}_{1 \mathrm{x}}$ ) <br> In 2-x Mode (f CLK2x) | $\begin{gathered} -2 \\ 2 \end{gathered}$ | $\begin{gathered} 2 \\ 25 \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{gathered} (1,3,13,14) \\ (1,3) \end{gathered}$ |
| T | PCLK2:1 Period | In 1-x Mode (f $\mathrm{f}_{\mathrm{CK} 1 \mathrm{x}}$ ) <br> In 2-x Mode (f $\mathrm{f}_{\mathrm{CLK}}$ 2x) |  |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{gathered} (1,13) \\ (1,3) \\ \hline \end{gathered}$ |
| TPH | PCLK2:1 High Time |  | (T/2) - 2 | T/2 | ns | $(1,13)$ |
| $\mathrm{T}_{\mathrm{PL}}$ | PCLK2:1 Low Time |  | (T/2) - 2 | T/2 | ns | $(1,13)$ |
| TPR | PCLK2:1 Rise Time |  | 1 | 4 | ns | $(1,3)$ |
| TPF | PCLK2:1 Fall Time |  | 1 | 4 | ns | $(1,3)$ |
| SYNCHRONOUS OUTPUTS(10) |  |  |  |  |  |  |
| Tov $\mathrm{T}_{\mathrm{OH}}$ |  |  | 3 3 6 3 4 5 3 4 4 4 3 $\mathrm{~T} / 2+3$ 2 3 | 14 16 18 18 16 16 16 16 16 18 16 $\mathrm{~T} / 2+14$ 14 18 | ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns | $(6,11)$ $(6,11)$ |
| TOF | Output Float for all outputs |  | 3 | 22 | ns | (6) |
| SYNCHRONOUS INPUTS(10) |  |  |  |  |  |  |
| TIS | Input Setup <br> TIS1 <br> TIS2 <br> $\mathrm{T}_{\text {IS3 }}$ <br> TIS4 | $\begin{array}{r} \frac{\text { D31:0 }}{\text { BOFF }} \\ \overline{\text { BTERM }} / \begin{array}{c} \text { READY } \\ \text { HOLD } \end{array} \end{array}$ | $\begin{gathered} 3 \\ 17 \\ 7 \\ 7 \\ \hline \end{gathered}$ |  | ns ns ns ns | $\begin{aligned} & (1,11) \\ & (1,11) \\ & (1,11) \\ & (1,11) \end{aligned}$ |
| $\mathrm{T}_{\mathrm{IH}}$ | Input Hold <br> $\mathrm{T}_{\mathrm{IH} 1}$ <br> TIH2 <br> $\mathrm{T}_{\mathrm{IH} 3}$ <br> $\mathrm{T}_{\mathrm{IH} 4}$ | $\overline{\text { BTERM } / \frac{\frac{\text { D31:0 }}{\text { ROAFF }}}{\text { HOLD }}}$ | $\begin{aligned} & 5 \\ & 5 \\ & 2 \\ & 3 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{aligned} & (1,11) \\ & (1,11) \\ & (1,11) \\ & (1,11) \end{aligned}$ |

AC Characteristics - 80960CF-30
(80960CF-30 only, under the conditions described in Section 4.2, Operating Conditions and Section 4.5.1, AC Test Conditions.) See notes which follow this table. (Continued)

| Symbol | Parameter | Min | Max | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RELATIVE OUTPUT TIMINGS ${ }^{(9,7)}$ |  |  |  |  |  |
| TAVSH1 | A31:2 Valid to $\overline{\text { ADS Rising }}$ | T-4 | T + 4 | ns |  |
| $\mathrm{T}_{\text {AVSH2 }}$ | $\overline{\mathrm{BE} 3: 0}, \mathrm{~W} / \overline{\mathrm{R}}, \overline{\mathrm{SUP}}, \mathrm{D} / \overline{\mathrm{C}}$, $\overline{\mathrm{DMA}}, \overline{\mathrm{DACK3}: 0}$ Valid to $\overline{\mathrm{ADS}}$ Rising | T-6 | T+6 | ns |  |
| TAVEL1 | A31:2 Valid to $\overline{\text { DEN }}$ Falling | T-4 | T+4 | ns |  |
| $\mathrm{T}_{\text {AVEL2 }}$ | $\overline{B E 3: 0}, \mathrm{~W} / \overline{\mathrm{R}}, \mathrm{SUP}, \overline{\mathrm{INST}}$, $\overline{\mathrm{DMA}}, \overline{\mathrm{DACK3}} \mathbf{0} 0 \mathrm{Valid}$ to $\overline{\mathrm{DEN}}$ Falling | T-6 | T+6 | ns |  |
| $\mathrm{T}_{\text {NLQV }}$ | WAIT Falling to Output Data Valid | $\pm 6$ |  | ns |  |
| TDVNH | Output Data Valid to WAIT Rising | N*T-6 | N*T + 6 | ns | (4) |
| $\mathrm{T}_{\text {NLNH }}$ | $\overline{\text { WAIT Falling to WAIT Rising }}$ | $\mathrm{N} * \mathrm{~T} \pm 4$ |  | ns | (4) |
| $\mathrm{T}_{\text {NHQX }}$ | Output Data Hold after WAIT Rising | $(\mathrm{N}+1) * \mathrm{~T}-6$ | $(\mathrm{N}+1) * \mathrm{~T}+6$ | ns | (5) |
| TEHTV | DT/㙰 Hold after $\overline{\text { DEN }}$ High | T/2-6 | $\infty$ | ns | (6) |
| TTVEL | DT/可 Valid to $\overline{\mathrm{DEN}}$ Falling | T/2-4 | $\mathrm{T} / 2+4$ | ns | (7) |

## RELATIVE INPUT TIMINGS(7)

| $\mathrm{T}_{\text {IS5 }}$ | RESET Input Setup (2x Clock Mode) | 6 | ns | (14) |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\mathrm{IH} 5}$ | RESET Input Hold (2x Clock Mode) | 5 | ns | (14) |
| $\mathrm{T}_{\text {IS6 }}$ | DREQ3:0 Input Setup | 12 | ns | (8) |
| $\mathrm{T}_{\text {IH6 }}$ | DREQ3:0 Input Hold | 7 | ns | (8) |
| $\mathrm{T}_{\text {IS7 }}$ | $\overline{\text { XINT7:0, }} \overline{\text { NMI }}$ Input Setup | 7 | ns | (8) |
| $\mathrm{T}_{\mathrm{IH} 7}$ | XINT7:0, $\overline{\text { NMI }}$ Input Hold | 3 | ns | (8) |
| $\mathrm{T}_{\text {IS8 }}$ | RESET Input Setup (1x Clock Mode) | 3 | ns | (15) |
| $\mathrm{T}_{\mathrm{IH} 8}$ | RESET Input Hold (1x Clock Mode) | $\mathrm{T} / 4+1$ | ns | (15) |

NOTES:

1. See Section 4.5.2, AC Timing Waveforms for waveforms and definitions.
2. See Figure 22 for capacitive derating information for output delays and hold times.
3. See Figure 23 for capacitive derating information for rise and fall times.
4. Where N is the number of $\mathrm{N}_{\text {RAD }}, \mathrm{N}_{\text {RDD }}$, $\mathrm{N}_{\text {WAD }}$, or $\mathrm{N}_{\text {WDD }}$ wait states that are programmed in the Bus Controller Region Table. When there are no wait states in an access, WAIT never goes active.
5. $N=$ Number of wait states inserted with READY.
6. Output Data and/or DT/ $\overline{\mathrm{R}}$ may be driven indefinitely following a cycle if there is no subsequent bus activity.
7. See Notes 1, 2 and 3.
8. Since asynchronous inputs are synchronized internally by the 80960CF they have no required setup or hold times in order to be recognized and for proper operation. However, to guarantee recognition of the input at a particular edge of PCLK2:1 the setup times shown must be met. Asynchronous inputs must be active for at least two consecutive PCLK2:1 rising edges to be seen by the processor.
9. These specifications are guaranteed by the processor.
10. These specifications must be met by the system for proper operation of the processor
11. This timing is dependent upon the loading of PCLK2:1. Use the derating curves of Section 4.5 .3 to adjust the timing for PCLK2:1 loading.
12. In the $1-x$ input clock mode, the maximum input clock period is limited to 125 ns while the processor is operating. When the processor is in reset, the input clock may stop even in 1-x mode.
13. When in the $1-x$ input clock mode, these specifications assume a stable input clock with a period variation of less than $\pm 0.1 \%$ between adjacent cycles.
14. In $2 x$ clock mode, RESET is an asynchronous input which has no required setup and hold time for proper operation. However, to guarantee the device exits reset synchronized to a particular clock edge, the RESET pin must meet setup and hold times to the falling edge of the CLKIN. (See Figure 28a.)
15. In $1 x$ clock mode, RESET is an asynchronous input which has no required setup and hold time for proper operation. However, to guarantee the device exits reset synchronized to a particular clock edge, the RESET pin must be deasserted while CLKIN is high and meet setup and hold times to the rising edge of the CLKIN. (See Figure 28b.)

AC Characteristics - 80960CF-25
(80960CF-25 only, under the conditions described in Section 4.2, Operating Conditions and Section 4.5.1, AC Test Conditions.)

| Symbol | Parameter |  | Min | Max | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CLOCK(10) |  |  |  |  |  |  |
| $\mathrm{T}_{\text {F }}$ | CLKIN Frequency |  | 0 | 50 | MHz | (1) |
| $\mathrm{T}_{\mathrm{C}}$ | CLKIN Period | In 1-x Mode (fCLK1x) In 2-x Mode (fCLK2x) | $\begin{aligned} & 40 \\ & 20 \end{aligned}$ | $\begin{gathered} 125 \\ \infty \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \\ & \hline \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \\ \hline \end{gathered}$ |
| $\mathrm{T}_{\text {CS }}$ | CLKIN Period Stability | In 1-x Mode (fCLK1x) |  | $\pm 0.1 \%$ | $\Delta$ | $(1,13)$ |
| $\mathrm{T}_{\text {CH }}$ | CLKIN High Time | In 1-x Mode (fCLK1x) In 2-x Mode (fCLK2x) | $\begin{aligned} & 8 \\ & 8 \end{aligned}$ | $\begin{gathered} 62.5 \\ \infty \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \\ & \hline \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \end{gathered}$ |
| $\mathrm{T}_{\mathrm{CL}}$ | CLKIN Low Time | $\ln 1-x$ Mode (fCLK1x) In 2-x Mode (fCLK2x) | $\begin{aligned} & 8 \\ & 8 \end{aligned}$ | $\begin{gathered} 62.5 \\ \infty \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \end{gathered}$ |
| $\mathrm{T}_{\text {CR }}$ | CLKIN Rise Time |  | 0 | 6 | ns | (1) |
| TCF | CLKIN Fall Time |  | 0 | 6 | ns | (1) |
| OUTPUT CLOCKS ${ }^{(9)}$ |  |  |  |  |  |  |
| $\mathrm{T}_{\text {CP }}$ | CLKIN to PCLK2:1 Delay | In 1-x Mode (fCLK1x) In 2-x Mode (fCLK2x) | $\begin{gathered} -2 \\ 2 \end{gathered}$ | $\begin{gathered} 2 \\ 25 \end{gathered}$ | ns | $\begin{gathered} (1,3,13,14) \\ (1,3) \end{gathered}$ |
| T | PCLK2:1 Period | In 1-x Mode (fCLK1x) In 2-x Mode (fCLK2x) |  |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{aligned} & (1,13) \\ & (1,3) \end{aligned}$ |
| $\mathrm{T}_{\text {PH }}$ | PCLK2:1 High Time |  | (T/2) - 3 | T/2 | ns | $(1,13)$ |
| $\mathrm{T}_{\text {PL }}$ | PCLK2:1 Low Time |  | (T/2) - 3 | T/2 | ns | $(1,13)$ |
| $\mathrm{T}_{\text {PR }}$ | PCLK2:1 Rise Time |  | 1 | 4 | ns | $(1,3)$ |
| $\mathrm{T}_{\text {PF }}$ | PCLK2:1 Fall Time |  | 1 | 4 | ns | $(1,3)$ |
| SYNCHRONOUS OUTPUTS(10) |  |  |  |  |  |  |
| $\begin{aligned} & \mathrm{T}_{\mathrm{OV}} \\ & \mathrm{~T}_{\mathrm{OH}} \end{aligned}$ |  |  | 3 <br> 3 <br> 6 <br> 3 <br> 4 <br> 5 <br> 3 <br> 4 <br> 4 <br> 4 <br> 3 <br> $\mathrm{~T} / 2+3$ <br> 2 <br> 3 | 16 <br> 18 <br> 20 <br> 20 <br> 18 <br> 18 <br> 18 <br> 18 <br> 18 <br> 20 <br> 18 <br> $\mathrm{~T} / 2+16$ <br> 16 <br> 20 | ns ns ns ns ns ns ns ns ns ns ns ns ns ns | $(6,11)$ $(6,11)$ |
| TOF | Output Float for all outputs |  | 3 | 22 | ns | (6) |
| SYNCHRONOUS INPUTS(10) |  |  |  |  |  |  |
| TIS | Input Setup $T_{\text {IS1 }}$ $T_{\text {IS2 }}$ $T_{\text {IS3 }}$ $T_{\text {IS4 }}$ Ipla | $\overline{\text { BTERM }} /$D31:0 <br> BOFF <br> READY <br> HOLD | $\begin{gathered} 5 \\ 19 \\ 9 \\ 9 \\ \hline \end{gathered}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \hline \end{aligned}$ | $\begin{aligned} & (1,11) \\ & (1,11) \\ & (1,1) \\ & (1,11) \\ & \hline \end{aligned}$ |
| $\mathrm{T}_{\mathrm{IH}}$ | Input Hold <br> $\mathrm{T}_{\mathrm{IH} 1}$ <br> $\mathrm{T}_{\mathrm{IH} 2}$ <br> $\mathrm{T}_{\mathrm{IH} 3}$ <br> $\mathrm{T}_{\mathrm{IH} 4}$ |  | $\begin{aligned} & 5 \\ & 7 \\ & 2 \\ & 5 \end{aligned}$ |  | ns ns ns ns | $\begin{aligned} & (1,11) \\ & (1,11) \\ & (1,1) \\ & (1,11) \\ & \hline \end{aligned}$ |

AC Characteristics - 80960CF-25
(80960CF-25 only, under the conditions described in Section 4.2, Operating Conditions and Section 4.5.1, AC Test Conditions.) (Continued)

| Symbol | Parameter | Min | Max | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RELATIVE OUTPUT TIMINGS ${ }^{(9,7)}$ |  |  |  |  |  |
| T ${ }_{\text {AVSH1 }}$ | A31:2 Valid to $\overline{\text { ADS Rising }}$ | T-4 | T+4 | ns |  |
| TAVSH2 | $\overline{B E 3: 0}, \mathrm{~W} / \overline{\mathrm{R}}, \overline{\mathrm{SUP}}, \mathrm{D} / \overline{\mathrm{C}}$, $\overline{\mathrm{DMA}}, \overline{\mathrm{DACK3}}: 0$ Valid to $\overline{\mathrm{ADS}}$ Rising | T-6 | T+6 | ns |  |
| TAVEL1 | A31:2 Valid to $\overline{\mathrm{DEN}}$ Falling | T-4 | T+4 | ns |  |
| TAVEL2 | $\overline{B E 3: 0}, \mathrm{~W} / \overline{\mathrm{R}}, \overline{\mathrm{SUP}}, \overline{\mathrm{INST}}$, $\overline{\mathrm{DMA}}, \overline{\mathrm{DACK3}} \mathbf{0}$ Valid to $\overline{\mathrm{DEN}}$ Falling | T-6 | T+6 | ns |  |
| T NLQV | WAIT Falling to Output Data Valid | $\pm 6$ |  | ns |  |
| TDVNH | Output Data Valid to WAIT Rising | N*T-6 | N*T + 6 | ns | (4) |
| $\mathrm{T}_{\text {NLNH }}$ | WAIT Falling to WAIT Rising | $\mathrm{N} * \mathrm{~T} \pm 4$ |  | ns | (4) |
| $\mathrm{T}_{\text {NHQX }}$ | Output Data Hold after WAIT Rising | $(\mathrm{N}+1) * \mathrm{~T}-6$ | $(\mathrm{N}+1) * \mathrm{~T}+6$ | ns | (5) |
| TEHTV | DT/不 Hold after DEN High | T/2-6 | $\infty$ | ns | (6) |
| TTVEL | DT/ $\overline{\mathrm{R}}$ Valid to $\overline{\mathrm{DEN}}$ Falling | T/2-4 | $\mathrm{T} / 2+4$ | ns | (7) |
| RELATIVE INPUT TIMINGS(7) |  |  |  |  |  |
| $\mathrm{T}_{\text {IS5 }}$ | RESET Input Setup (2x Clock Mode | 8 |  | ns | (14) |
| $\mathrm{T}_{\text {IH5 }}$ | RESET Input Hold (2x Clock Mode) | 7 |  | ns | (14) |
| $\mathrm{T}_{\text {IS6 }}$ | DREQ3:0 Input Setup | 14 |  | ns | (8) |
| $\mathrm{T}_{\text {IH6 }}$ | DREQ3:0 Input Hold | 9 |  | ns | (8) |
| TIS7 | $\overline{\text { XINT7:0, }} \overline{\text { NMI }}$ Input Setup | 9 |  | ns | (8) |
| $\mathrm{T}_{\text {IH7 }}$ | XINT7:0, $\overline{\text { NMI }}$ Input Hold | 5 |  | ns | (8) |
| $\mathrm{T}_{\text {IS8 }}$ | RESET Input Setup (1x Clock Mode) | 3 |  | ns | (15) |
| $\mathrm{T}_{\text {IH8 }}$ | RESET Input Hold (1x Clock Mode) | $\mathrm{T} / 4+1$ |  | ns | (15) |

## NOTES:

(1) See Section 4.5.2, AC Timing Waveforms for waveforms and definitions.
(2) See Figure 22 for capacitive derating information for output delays and hold times.
(3) See Figure 23 for capacitive derating information for rise and fall times.
(4) Where $N$ is the number of $N_{\text {RAD }}, N_{\text {RDD }}$, NWAD, or NWDD wait states that are programmed in the Bus Controller Region Table. When there are no wait states in an access, WAIT never goes active.
(5) $\mathrm{N}=$ Number of wait states inserted with READY.
(6) Output Data and/or DT/ $\bar{R}$ may be driven indefinitely following a cycle if there is no subsequent bus activity
(7) See Notes 1, 2 and 3.
(8) Since asynchronous inputs are synchronized internally by the 80960CF they have no required setup or hold times in order to be recognized and for proper operation. However, to guarantee recognition of the input at a particular edge of PCLK2:1 the setup times shown must be met. Asynchronous inputs must be active for at least two consecutive PCLK2:1 rising edges to be seen by the processor.
(9) These specifications are guaranteed by the processor.
(10) These specifications must be met by the system for proper operation of the processor.
(11) This timing is dependent upon the loading of PCLK2:1. Use the derating curves of Section 4.5 .3 to adjust the timing for PCLK2:1 loading.
(12) In the 1-x input clock mode, the maximum input clock period is limited to 125 ns while the processor is operating. When the processor is in reset, the input clock may stop even in 1 -x mode.
(13) When in the $1-\mathrm{x}$ input clock mode, these specifications assume a stable input clock with a period variation of less than $\pm 0.1 \%$ between adjacent cycles.
(14) In $2 x$ clock mode, RESET is an asynchronous input which has no required setup and hold time for proper operation. However, to guarantee the device exits reset synchronized to a particular clock edge, the RESET pin must meet setup and hold times to the falling edge of the CLKIN. (See Figure 28a.)
(15) In 1x clock mode, RESET is an asynchronous input which has no required setup and hold time for proper operation. However, to guarantee the device exits reset synchronized to a particular clock edge, the RESET pin must be deasserted while CLKIN is high and meet setup and hold times to the rising edge of the CLKIN. (See Figure 28b.)

AC Characteristics - 80960CF-16
(80960CF-16 only, under the conditions described in Section 4.2, Operating Conditions and Section 4.5.1, AC Test Conditions.) (Continued)

| Symbol | Parameter |  | Min | Max | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CLOCK(10) |  |  |  |  |  |  |
| $\mathrm{T}_{\text {F }}$ | CLKIN Frequency |  | 0 | 32 | MHz | (1) |
| $\mathrm{T}_{\mathrm{C}}$ | CLKIN Period | In 1-x Mode (fCLK1x) <br> In 2-x Mode (fCLK2x) | $\begin{gathered} 62.5 \\ 31.25 \end{gathered}$ | $\begin{gathered} 125 \\ \infty \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \\ \hline \end{gathered}$ |
| $\mathrm{T}_{\mathrm{CS}}$ | CLKIN Period Stability | In 1-x Mode (fCLK1x) |  | $\pm 0.1 \%$ | $\Delta$ | $(1,13)$ |
| $\mathrm{T}_{\mathrm{CH}}$ | CLKIN High Time | In 1-x Mode (fCLK1x) <br> In 2-x Mode (fCLK2x) | $\begin{aligned} & \hline 10 \\ & 10 \end{aligned}$ | $\begin{gathered} 62.5 \\ \infty \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \end{gathered}$ |
| $\mathrm{T}_{\text {CL }}$ | CLKIN Low Time | In 1-x Mode (fCLK1x) <br> In 2-x Mode (fCLK2x) | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ | $\begin{gathered} 62.5 \\ \infty \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{gathered} (1,12) \\ (1) \end{gathered}$ |
| $\mathrm{T}_{\mathrm{CR}}$ | CLKIN Rise Time |  | 0 | 6 | ns | (1) |
| $\mathrm{T}_{\text {CF }}$ | CLKIN Fall Time |  | 0 | 6 | ns | (1) |
| OUTPUT CLOCKS(9) |  |  |  |  |  |  |
| $\mathrm{T}_{\text {CP }}$ | CLKIN to PCLK2:1 Delay | $\ln 1$-x Mode (fCLK1x) In 2-x Mode (fCLK2x) | $\begin{gathered} -2 \\ 2 \end{gathered}$ | $\begin{gathered} 2 \\ 25 \\ \hline \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{gathered} (1,3,13,14) \\ (1,3) \\ \hline \end{gathered}$ |
| T | PCLK2:1 Period | In 1-x Mode (fcLK $1 \times$ ) In 2-x Mode (fCLK2x) |  |  | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ | $\begin{gathered} (1,13) \\ (1,3) \end{gathered}$ |
| $\mathrm{T}_{\mathrm{PH}}$ | PCLK2:1 High Time |  | (T/2) - 4 | T/2 | ns | $(1,13)$ |
| $\mathrm{T}_{\mathrm{PL}}$ | PCLK2:1 Low Time |  | (T/2) - 4 | T/2 | ns | $(1,13)$ |
| $\mathrm{T}_{\text {PR }}$ | PCLK2:1 Rise Time |  | 1 | 4 | ns | $(1,3)$ |
| TPF | PCLK2:1 Fall Time |  | 1 | 4 | ns | $(1,3)$ |
| SYNCHRONOUS OUTPUTS(10) |  |  |  |  |  |  |
| $\begin{aligned} & \text { Tov } \\ & \mathrm{T}_{\mathrm{OH}} \end{aligned}$ |  |  | $\begin{gathered} 3 \\ 3 \\ 6 \\ 3 \\ 4 \\ 5 \\ 3 \\ 4 \\ 4 \\ 4 \\ 3 \\ \mathrm{~T} / 2+3 \\ 2 \\ 3 \\ \hline \end{gathered}$ | 18 <br> 20 <br> 22 <br> 22 <br> 20 <br> 20 <br> 20 <br> 20 <br> 20 <br> 22 <br> 20 <br> $\mathrm{~T} / 2+18$ <br> 18 <br> 22 | ns ns ns ns ns ns ns ns ns ns ns ns ns ns | $(6,11)$ $(6,11)$ |
| $\mathrm{T}_{\mathrm{OF}}$ | Output Float for all outputs |  | 3 | 22 | ns | (6) |
| SYNCHRONOUS INPUTS(10) |  |  |  |  |  |  |
| $\mathrm{T}_{\text {IS }}$ | $\begin{aligned} & \text { Input Setup } \\ & T_{\text {IS } 1} \\ & T_{\text {IS2 }} \\ & T_{\text {IS3 }} \\ & T_{\text {IS4 }} \\ & \hline \end{aligned}$ | D31:0 <br> BTERM/ $/$BEFF <br> HOLS <br> HOLD | $\begin{gathered} 5 \\ 21 \\ 9 \\ 9 \\ \hline \end{gathered}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \\ & \text { ns } \\ & \mathrm{ns} \\ & \hline \end{aligned}$ | $\begin{aligned} & (1,11) \\ & (1,11) \\ & (1,1) \\ & (1,11) \\ & \hline \end{aligned}$ |
| $\mathrm{T}_{\mathrm{IH}}$ | $\begin{aligned} & \text { Input Hold } \\ & T_{\text {IH1 }} \\ & T_{1 H 2} \\ & T_{\text {IH3 }} \\ & T_{\text {IH4 }} \\ & \hline \end{aligned}$ | $\begin{gathered} \frac{\text { D31:0 }}{\text { BOFF }} \\ \text { BTERM/READY } \\ \text { HOLD } \end{gathered}$ | $\begin{aligned} & 5 \\ & 7 \\ & 2 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \\ & \hline \end{aligned}$ | $\begin{aligned} & (1,11) \\ & (1,11) \\ & (1,1) \\ & (1,11) \\ & \hline \end{aligned}$ |

## AC Characteristics - 80960CF-16

(80960CF-16 only, under the conditions described in Section 4.2, Operating Conditions and Section 4.5.1, AC Test Conditions.) (Continued)

| Symbol | Parameter | Min | Max | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RELATIVE OUTPUT TIMINGS(9,7) |  |  |  |  |  |
| $\mathrm{T}_{\text {AVSH1 }}$ | A31:2 Valid to $\overline{\text { ADS Rising }}$ | T-4 | T + 4 | ns |  |
| $\mathrm{T}_{\text {AVSH2 }}$ | $\overline{\text { BE3:0 }}, \mathrm{W} / \overline{\mathrm{R}}, \overline{\mathrm{SUP}}, \mathrm{D} / \overline{\mathrm{C}}$, $\overline{\mathrm{DMA}}, \overline{\mathrm{DACK3}} \mathbf{0}$ Valid to $\overline{\mathrm{ADS}}$ Rising | T-6 | T + 6 | ns |  |
| $\mathrm{T}_{\text {AVEL1 }}$ | A31:2 Valid to $\overline{\text { DEN Falling }}$ | T-6 | T + 6 | ns |  |
| $\mathrm{T}_{\text {AVEL2 }}$ | $\overline{\mathrm{BE}} \mathrm{B}: 0, \mathrm{~W} / \overline{\mathrm{R}}, \overline{\mathrm{SUP}}, \mathrm{INST}$, <br> $\overline{D M A}, \overline{D A C K 3: 0 ~ V a l i d ~ t o ~} \overline{\text { DEN }}$ Falling | T-6 | T + 6 | ns |  |
| $\mathrm{T}_{\text {NLQV }}$ | WAIT Falling to Output Data Valid | $\pm 6$ |  | ns |  |
| T ${ }_{\text {dVNH }}$ | Output Data Valid to WAIT Rising | N*T-6 | N*T + 6 | ns | (4) |
| $\mathrm{T}_{\text {NLNH }}$ | $\overline{\text { WAIT Falling to } \overline{\text { WAIT }} \text { Rising }}$ | N*T $\pm 4$ |  | ns | (4) |
| $\mathrm{T}_{\text {NHQX }}$ | Output Data Hold after WAIT Rising | $(\mathrm{N}+1) * \mathrm{~T}-6$ | $(\mathrm{N}+1) * \mathrm{~T}+6$ | ns | (5) |
| TEHTV | DT/R Hold after DEN High | T/2-6 | $\infty$ | ns | (6) |
| T TVEL | DT/ $\overline{\mathrm{R}}$ Valid to $\overline{\mathrm{DEN}}$ Falling | T/2-4 | $\mathrm{T} / 2+4$ | ns | (7) |
| RELATIVE INPUT TIMINGS(7) |  |  |  |  |  |
| TIS5 | RESET Input Setup (2x Clock Mode) | 10 |  | ns | (14) |
| $\mathrm{T}_{\text {IH5 }}$ | RESET Input Hold (2x Clock Mode) | 9 |  | ns | (14) |
| TIS6 | DREQ3:0 Input Setup | 16 |  | ns | (8) |
| $\mathrm{T}_{\text {IH6 }}$ | DREQ3:0 Input Hold | 11 |  | ns | (8) |
| $\mathrm{T}_{\text {IS7 }}$ | XINT7:0, $\overline{\text { NMI }}$ Input Setup | 9 |  | ns | (8) |
| $\mathrm{T}_{1 H 7}$ | XINT7:0, $\overline{\text { NMI }}$ Input Hold | 5 |  | ns | (8) |
| $\mathrm{T}_{\text {IS8 }}$ | RESET Input Setup (1x Clock Mode) | 3 |  | ns | (15) |
| $\mathrm{T}_{\text {IH8 }}$ | RESET Input Hold (1x Clock Mode) | T/4 + 1 |  | ns | (15) |

## NOTES:

(1) See Section 4.5.2, AC Timing Waveforms for waveforms and definitions.
(2) See Figure 22 for capacitive derating information for output delays and hold times.
(3) See Figure 23 for capacitive derating information for rise and fall times.
(4) Where $N$ is the number of $N_{\text {RAD }}, N_{\text {RDD }}$, $N_{\text {WAD }}$, or NWDD wait states that are programmed in the Bus Controller Region Table. When there are no wait states in an access, WAIT never goes active.
(5) $N=$ Number of wait state inserted with READY.
(6) Output Data and/or $D T / \bar{R}$ may be driven indefinitely following a cycle if there is no subsequent bus activity.
(7) See Notes 1, 2 and 3.
(8) Since asynchronous inputs are synchronized internally by the 80960CF they have no required setup or hold times in order to be recognized and for proper operation. However, to guarantee recognition of the input at a particular edge of PCLK2:1 the setup times shown must be met. Asynchronous inputs must be active for at least two consecutive PCLK2:1 rising edges to be seen by the processor.
(9) These specifications are guaranteed by the processor.
(10) These specifications must be met by the system for proper operation of the processor.
(11) This timing is dependent upon the loading of PCLK2:1. Use the derating curves of Figure 22 to adjust the timing for PCLK2:1 loading.
(12) In the 1-x input clock mode, the maximum input clock period is limited to 125 ns while the processor is operating. When the processor is in reset, the input clock may stop even in $1-x$ mode.
(13) When in the $1-x$ input clock mode, these specifications assume a stable input clock with a period variation of less than $\pm 0.1 \%$ between adjacent cycles.
(14) In $2 x$ clock mode, RESET is an asynchronous input which has no required setup and hold time for proper operation. However, to guarantee the device exits reset synchronized to a particular clock edge, the RESET pin must meet setup and hold times to the falling edge of the CLKIN. (See Figure 28a.)
(15) In $1 \times$ clock mode, RESET is an asynchronous input which has no required setup and hold time for proper operation. However, to guarantee the device exits reset synchronized to a particular clock edge, the RESET pin must be deasserted while CLKIN is high and meet setup and hold times to the rising edge of the CLKIN. (See Figure 28b.)

### 4.5.1. AC TEST CONDITIONS



The AC Specifications in Section 4.5 are tested with the 50 pf load shown in Figure 9. See Figure 16 to see how timings vary with load capacitance.

Specifications are measured at the 1.5 V crossing point, unless otherwise indicated. Input waveforms are assumed to have a rise-and-fall time of $\leq 2 \mathrm{~ns}$ from 0.8 V to 2.0 V . See Section 4.5.2, AC Timing Waveforms for AC spec definitions, test points and illustrations.

Figure 9. AC Test Load
4.5.2. AC TIMING WAVEFORMS


Figure 10a. Input and Output Clocks Waveform


Figure 10b. CLKIN Waveform


Figure 11. Output Delay and Float Waveform


Figure 12a. Input Setup and Hold Waveform


- OUTPUT DELAY - The maximum output delay is referred to as the Output Valid Delay ( $\mathrm{T}_{\mathrm{OV}}$ ). The minimum output delay is referred to as the Output Hold ( $\mathrm{T}_{\mathrm{OH}}$ ).
(ㅁac)
- OUTPUT FLOAT DELAY - The output float condition occurs when the maximum output current becomes less than $\mathbf{I}_{\text {LO }}$ in magnitude.

- INPUT SETUP AND HOLD - The input setup and hold requirements specify the sampling window during which synchronous inputs must be stable for correct processor operation.


Figure 12b. $\overline{\text { NMI }}, \overline{\text { XINT7:0 }}$ Input Setup and Hold Waveform


Figure 13. Hold Acknowledge Timings


Figure 14. Bus Back-Off ( $\overline{\text { BOFF }}$ ) Timings


Figure 15. Relative Timings Waveforms
4.5.3 DERATING CURVES


Figure 16. Output Delay or Hold vs Load Capacitance

(a) All outputs except: $\overline{\mathrm{LOCK}}, \overline{\mathrm{DMA}}, \overline{\mathrm{SUP}}, \mathrm{HOLDA}, \mathrm{BREQ}$, (a) ACK3:0, $\overline{\text { EOP3:0 }} / \overline{\text { TC3: }}$ FAIL
 $\begin{array}{lll}\text { (b) } \overline{\text { LOCK }}, \overline{\text { DMA }}, \\ \overline{\text { EOP3:0 }} / \overline{\mathrm{TC} 3: 0}, \overline{\text { FAIL }} & \overline{\text { SUP, }}, & \text { HOLDA, } \\ \end{array}$

Figure 17. Rise and Fall Time Derating at Highest Operating Temperature and Minimum $\mathbf{V}_{\mathbf{C C}}$


Figure 18. Icc vs Frequency and Temperature

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### 5.0 RESET, BACKOFF AND HOLD ACKNOWLEDGE

The following table lists the condition of each processor output pin while RESET is asserted (low).

Table 10. Reset Conditions

| Pins | State During Reset (HOLDA inactive) ${ }^{1}$ |
| :---: | :---: |
| A31:A2 | Floating |
| D31:D0 | Floating |
| BE3:0 | Driven high (Inactive) |
| W/R | Driven low (Read) |
| $\overline{\text { ADS }}$ | Driven high (Inactive) |
| WAIT | Driven high (Inactive) |
| BLAST | Driven low (Active) |
| DT/ $\bar{R}$ | Driven low (Receive) |
| $\overline{\text { DEN }}$ | Driven high (Inactive) |
| $\overline{\text { LOCK }}$ | Driven high (Inactive) |
| BREQ | Driven low (Inactive) |
| D/ $\overline{\mathrm{C}}$ | Floating |
| $\overline{\text { DMA }}$ | Floating |
| SUP | Floating |
| FAIL | Driven low (Active) |
| DACK3 | Driven high (Inactive) |
| $\overline{\text { DACK2 }}$ | Driven high (Inactive) |
| DACK1 | Driven high (Inactive) |
| $\overline{\text { DACKO }}$ | Driven high (Inactive) |
| $\overline{\text { EOP/TC3 }}$ | Floating (set to input mode) |
| EOP/TC2 | Floating (set to input mode) |
| EOP/TC1 | Floating (set to input mode) |
| EOP/TC0 | Floating (set to input mode) |

NOTE:
(1) With regard to bus output pin state only, the Hold Acknowledge state takes precedence over the reset state. Although asserting the RESET pin will internally reset the processor, the processor's bus output pins will not enter the reset state if it has granted Hold Acknowledge to a previous HOLD request (HOLDA is active). Furthermore, the processor will grant new HOLD requests and enter the Hold Acknowledge state even while in reset.
For example, if HOLDA is not active and the processor is in the reset state, then HOLD is asserted, the processor's bus pins will enter the Hold Acknowledge state and HOLDA will be granted. The processor will not be able to perform memory accesses until the HOLD request is removed, even if the RESET pin is brought high. This operation is provided to simplify boot-up synchronization among multiple processors sharing the same bus.

The following table lists the condition of each processor output pin while HOLDA is asserted (low).

Table 11. Hold Acknowledge
and Backoff Conditions

| Pins | State During HOLDA |
| :---: | :---: |
| A31:A2 | Floating |
| D31:D0 | Floating |
| BE3:0 | Floating |
| W/㗈 | Floating |
| $\overline{\text { ADS }}$ | Floating |
| WAIT | Floating |
| $\overline{\text { BLAST }}$ | Floating |
| DT/R | Floating |
| $\overline{\text { DEN }}$ | Floating |
| LOCK | Floating |
| BREQ | Driven (high or low) |
| D/C | Floating |
| $\overline{\mathrm{DMA}}$ | Floating |
| SUP | Floating |
| $\overline{\text { FAIL }}$ | Driven high (Inactive) |
| $\overline{\text { DACK3 }}$ | Driven high (Inactive) |
| DACK2 | Driven high (Inactive) |
| $\overline{\text { DACK1 }}$ | Driven high (Inactive) |
| DACKO | Driven high (Inactive) |
| $\overline{\mathrm{EOP}} / \overline{\mathrm{TC} 3}$ | Driven if output |
| $\overline{\mathrm{EOP}} / \overline{\mathrm{TC} 2}$ | Driven if output |
| $\overline{\mathrm{EOP}} / \overline{\mathrm{TC1}}$ | Driven if output |
| EOP/TC0 | Driven if output |

### 6.0 BUS WAVEFORMS



Figure 19. Cold Reset Waveform
inted.


Figure 20. Warm Reset Waveform

- ADVANCE INPORMATRON


Figure 21. Entering the ONCE State


Figure 22a. Clock Synchronization in the 2x Clock Mode


NOTE:
In 1x clock mode, the RESET pin is actually sampled on the falling edge of 2XCLK. 2XCLK is an internal signal generated by the PLL and is not available on an external pin. Therefore, RESET is specified relative to the rising edge of CLKIN. The $\overline{\text { RESET }}$ pin is sampled when PCLK is high.

Figure 22b. Clock Synchronization in the 1x Clock Mode


Figure 23. Non-Burst, Non-Pipelined Requests without Wait States
inted.


Figure 24. Non-Burst, Non-Pipelined Read Request with Wait States


Figure 25. Non-Burst, Non-Pipelined Write Request with Wait States
intel.


Figure 26. Burst, Non-Pipelined Read Request without Wait States, 32-Bit Bus


Figure 27. Burst, Non-Pipelined Read Request with Wait States, 32-Bit Bus
intel.


Figure 28. Burst, Non-Pipelined Write Request without Wait States, 32-Bit Bus


Figure 29. Burst, Non-Pipelined Write Request with Wait States, 32-Bit Bus
inted.


Figure 30. Burst, Non-Pipelined Read Request with Wait States, 16-Bit Bus


Figure 31. Burst, Non-Pipelined Read Request with Wait States, 8-Bit Bus


Figure 32. Non-Burst, Pipelined Read Request without Wait States, 32-Bit Bus


Figure 33. Non-Burst, Pipelined Read Request with Wait States, 32-Bit Bus


Figure 34. Burst, Pipelined Read Request without Wait States, 32-Bit Bus


Figure 35. Burst, Pipelined Read Requests with Wait States, 32-Bit Bus
inted.


Figure 36. Burst, Pipelined Read Requests with Wait States, 16-Bit Bus


Figure 37. Burst, Pipelined Read Requests with Wait States, 8-Bit Bus
inted.


Figure 38. Using External READY


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NOTE:
$\overline{R E A D Y}$ adds memory access time to data transfers, whether or not the bus access is a burst access. $\overline{B T E R M}$ interrupts a bus access, whether or not the bus access has more data transfers pending. Either the READY signal or the $\overline{B T E R M}$ signal will terminate a bus access if the signal is asserted during the last (or only) data transfer of the bus access.

Figure 39. Terminating a Burst with BTERM


Figure 40. $\overline{B O F F}$ Functional Timing


Figure 41. $\overline{\text { HOLD }}$ Functional Timing


NOTES:

1. Case 1: $\overline{\mathrm{DREQ}}$ must deassert before $\overline{\mathrm{DACK}}$ deasserts. Applications are Fly-by and some packing and unpacking modes, in which loads are followed by loads, or stores are followed by stores.
2. Case 2: $\overline{\text { DREQ }}$ must be deasserted by the second clock (rising edge) after $\overline{\mathrm{DACK}}$ is driven high. Applications are non fly-by transfers and adjacent load-stores or store-loads.
3. DACKx is asserted for the duration of a DMA bus request. The request may consist of multiple bus accesses (defined by $\overline{A D S}$ and $\overline{B L A S T}$. Refer to User's Manual for "access", "request" definition.

Figure 42. $\overline{\text { DREQ }}$ and $\overline{\text { DACK }}$ Functional Timing


NOTE:
$\overline{\mathrm{EOP}}$ has the same AC Timing Requirements as $\overline{\mathrm{DREQ}}$ to prevent unwanted DMA requests.
$\overline{\mathrm{EOP}}$ is NOT edge triggered. $\overline{\mathrm{EOP}}$ must be held for a minimum of 2 clock cycles then $\overline{\mathrm{EOP}}$ must be deasserted within 15 clock cycles.

Figure 43. EOP Functional Timing


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## NOTE:

Terminal Count becomes active during the last bus request of a buffer transfer. If the last LOAD/STORE bus request is executed as multiple bus accesses, the TC will be active for the entire bus request. Refer to the User's Manual for further information.

Figure 44. Terminal Count Functional Timing


Figure 45. $\overline{\text { FAIL }}$ Functional Timing


Figure 46. A Summary of Aligned and Unaligned Transfers for Little Endian Regions


Figure 47. A Summary of Aligned and Unaligned Transfers for Little Endian Regions (Continued)


Figure 48. Idle Bus Operation

